FUJITSU SEMICONDUCTOR
DATA SHEET

DS07-13505-3E

16-bit Proprietary Microcontroller

CMOS

F²MC-16F MB90246A Series

MB90246A

■ DESCRIPTION

The MB90246A is a 16-bit microcontroller optimized for “mechatronics” control applications such as hard disk drive unit control.

The instruction set is based on the AT architecture of the F²MC*-16, 16H family, with additional high-level language supporting instruction, expanded addressing modes, enhanced multiplication and division instructions, and improved bit processing instructions. In addition, long-word data can now be processed due to the inclusion of a 32-bit accumulator.

The MB90246A has a multiply/accumulate unit as a peripheral resource, allowing easy realization of digital filters such as IIR or FIR. The MB90246A has abundant embedded peripheral features, such as 8-channel 8/10-bit A/D Converter, 3-channel 8-bit D/A Converter, UART, 4-channel 8-bit PWM timer, 3-channel + 1-channel timer, 2-channel input capture and 4-channel external interrupt.

* : F²MC stands for FUJITSU Flexible Microcontroller.

■ FEATURES

F²MC-16F CPU

- Minimum execution time: 62.5 ns (32 MHz oscillation: 5.0 V ±10%)
- Instruction set optimized for controller applications
- Instruction set supports high-level language (C language) and multitasking
- Improved execution speed: 8-byte queue
- Powerful interrupt functions (interrupt processing time 1.0 µs: 32 MHz oscillation)
- Automatic transfer function independent of instructions
- Extended intelligent I/O Service

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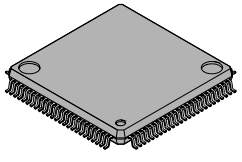
■ PACKAGE

100-pin Plastic LQFP



(FPT-100P-M05)

MB90246A Series

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- DSP unit
  Specific function for calculations of IIR
  A maximum of 8 product resulted from signed 16-bit × 16-bit multiplications can be accumulated.

  $Y_k = \sum_{n=0}^{N} b_n Y_{k-n} + \sum_{m=0}^{M} a_m X_{k-m}$ is executed in 0.625 µs (at a oscillation of 32 MHz, N = M = 3)

  The N and M value is set to a maximum of 3, independently.
- Internal RAM: mass production product RAM 4 Kbyte
  Depending on mode settings, data stored on RAM can be executed as CPU instructions.
- General-purpose ports: max. 57
- A/D converter: analog inputs: 8 channels
  Resolution: 10 bits
  Conversion time: min. 1.25 µs
  Switchable to 8/10 bits
  Number of registers for storing conversion results: 4
- 8-bit D/A converter: analog outputs: 3 channels
  Resolution: 8 bits
  Conversion time: typ. 10 µs
- 8-bit PWM timer: 4 channels
- 8-bit UART: 1 channel
- SSI (8/16-bit I/O simple serial interface (8 Mbps max.): 2 channels
- 16-bit free-run timer: operating clock: 0.25 µs
- 16-bit input capture: 2 channels
  Activated by selected edges
- 16-bit reload timer: 3 channels
- External interrupts: 4 channels
- Timebase timer: 18 bits
- Watchdog timer
- Clock gear function
- Low-power consumption modes
  Sleep mode
  Stop mode
  Hardware standby mode
- Package: LQFP-100
- CMOS 0.8 µm technology

■ PRODUCT LINEUP

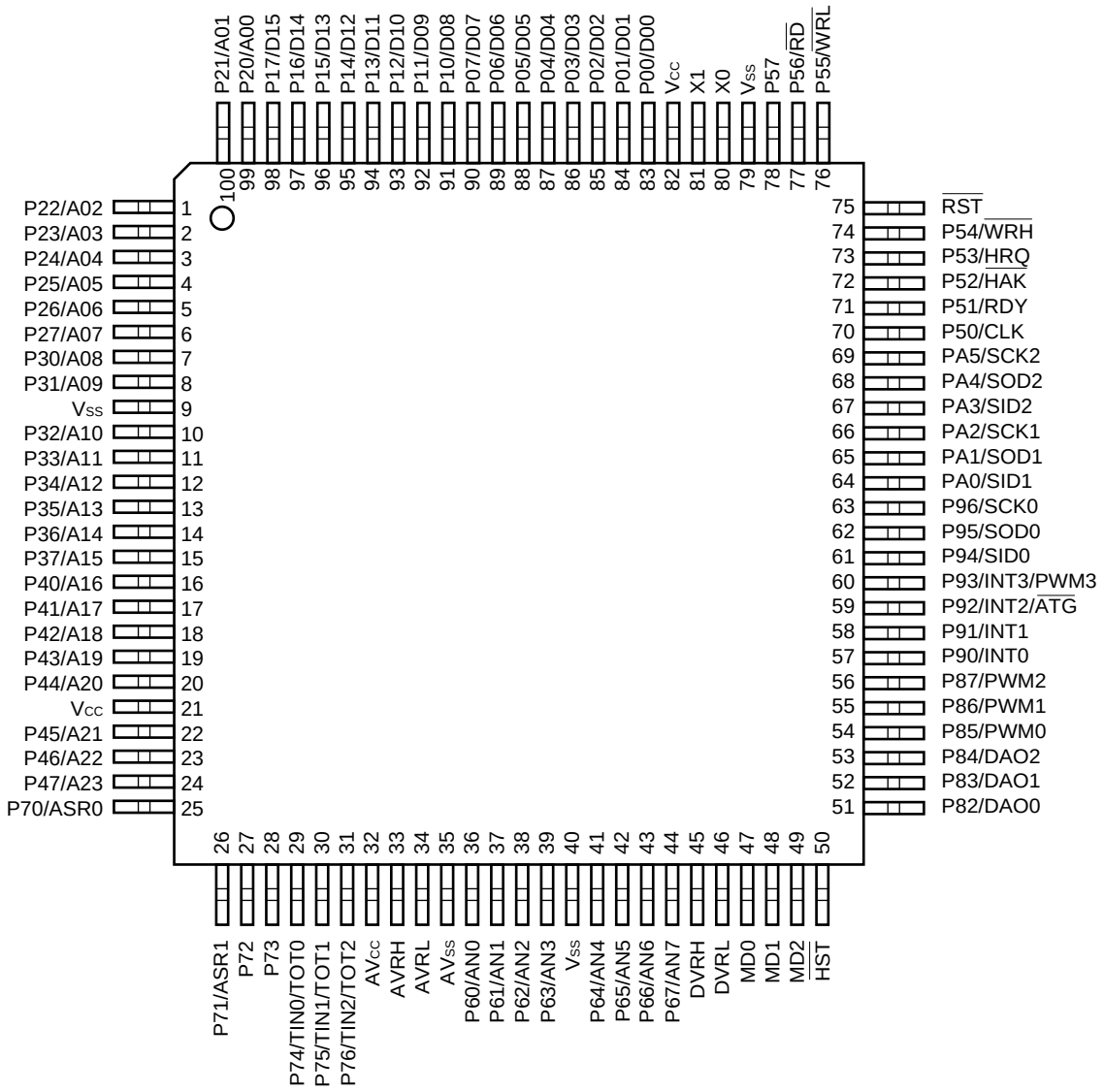
Parameter / Part number	MB90246A
Classification	Mass production products
RAM size	4 K × 8 bits
CPU function	F²MC-16F Number of instructions: 412 Minimum execution time: 62.5 ns/5 V ±10% Addressing mode: 25 types Signed multiply/divide instructions: available Instruction queue: 8 bytes
Ports	I/O ports (CMOS): 57 I/O ports (N-channel open-drain): 8 (P60 to P67) Total: 65
Multiply/accumulate module for IIR calculations	Performs a multiply/accumulate operation of $\sum_{n=0}^{N} b_n Y_{k-n} + \sum_{m=0}^{M} a_m X_{k-m}$ in 625 ns (N=M=3, at a machine clock frequency of 16 MHz)
A/D converter	Switchable to 10 bits/8 bits × 8 channels Conversion time: min. 1.25 µs Conversion result register: 4 words A scanning mode of up to 4 channels is available.
D/A converter	8 bits × 3 channels
Serial interface	UART × 1 channel: Internal proprietary baud rate generator
	SSI (I/O simple serial) × 2 channels, Max. transfer speed of 8 Mbps
Input capture	16 bits × 2 channels External interrupts activated selectively by rising, falling or both edges.
Free-run timer	16 bits × 1 channel (for generating base time in input capture operations) The count clock can be selected from four different frequencies, ϕ/4, ϕ/16, ϕ/32 or ϕ/64. (where ϕ is the machine clock frequency)
Reload timer	16 bits × 3 channels The count clock can be selected from three different frequencies, ϕ/2, ϕ/8 or ϕ/32. (where ϕ is the machine clock frequency)
PWM timer	8 bits × 4 channels
External interrupts	4-ch independent
Low-power consumption modes	Gear function, sleep mode, stop mode, hardware standby
Package	LQFP-100 (0.5 mm pitch, mounting hight 1.50 mm)
Operating power supply voltage	5.0 V ±10%/machine clock = 16 MHz (oscillation frequency 32 MHz)

Note: The RAM has an extra 64-word area reserved for multiply/accumulate operations.

MB90246A Series

■ PIN ASSIGNMENT

(Top View)



(FPT-100P-M05)

■ PIN DESCRIPTION

Pin no.	Pin name	Circuit type	Function
80	X0	A	Crystal oscillator pins (32 MHz)
81	X1		
47 to 49	MD0 to MD2	D	Operating mode selection input pins Connect directly to V_{CC} or V_{SS}.
75	$\overline{RST}$	B	External reset request input
50	$\overline{HST}$	D	Hardware standby input pin
83 to 90	P00 to P07	E	This pin cannot be used as general-purpose ports.
	D00 to D07		I/O pins for the lower 8 bits of the external data bus
91 to 98	P10 to P17	E	General-purpose I/O ports This function is available when the external bus 8-bit mode is selected.
	D08 to D15		I/O pins for the upper 8 bits of the external data bus This function is available when the 16-bit bus mode is selected.
99, 100 1 to 6	P20 to P27	F	These pins cannot be used as general-purpose ports.
	A00 to A07		Output pins for the lower 8 bits of the external address
7, 8 10 to 15	P30 to P37	F	General-purpose I/O ports This function is available when corresponding bit of the middle address control register specifies port.
	A08 to A15		Output pins for the middle 8 bits of the external address bus This function is available when corresponding bit of the middle address control register specifies address.
16 to 20 22 to 24	P40 to P47	F	General-purpose I/O ports This function is available when corresponding bit of the upper address control register specifies port.
	A16 to A23		Output pins for the upper 8 bits of the external address bus This function is available when corresponding bit of the upper address control register specifies address.
70	P50	F	General-purpose I/O port This function is available when CLK output is disabled.
	CLK		CLK output pin This function is available when CLK output is enabled.
71	P51	E	General-purpose I/O port This function is available when ready function is disabled.
	RDY		Ready input pin This function is available when ready function is enabled.
72	P52	E	General-purpose I/O port This function is available when hold function is disabled.
	$\overline{HAK}$		Hold acknowledge output pin This function is available when hold function is enabled.
73	P53	E	General-purpose I/O port This function is available when hold function is disabled.
	HRQ		Hold request input pin This function is available when hold function is enabled.
74	P54	F	General-purpose I/O port This function is available when the external bus 8-bit mode is selected and WR pin output is disabled.
	$\overline{WRH}$		Write strobe output pin for the upper eight bits of the data bus This function is available when the external bus 16-bit mode is selected and WR pin output is enabled.

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76	P55	F	General-purpose I/O port This function is available when WR pin output is disabled.
	$\overline{WRL}$		Write strobe output pin for the lower eight bits of the data bus This function is available when WR pin output is enabled.
77	P56	F	This pin cannot be used as a general-purpose port.
	$\overline{RD}$		Read strobe output pin for the data bus
78	P57	F	General-purpose I/O port
36 to 39	P60 to P63	H	N-ch open-drain type I/O ports When corresponding bit of the ADER are set to “0”, reading data register with an instruction other than read-modify-write group instructions reads the level on these pins, while data written on the data register is output on these pins directly.
	AN0 to AN3		A/D converter analog input pins Set corresponding bit of the ADER to “1”, and corresponding bit of the data register to “1”.
41 to 44	P64 to P67	H	N-ch open-drain type I/O ports When corresponding bit of the ADER are set to “0”, reading data register with an instruction other than read-modify-write group instructions reads the level on these pins, while data written on the data register is output on these pins directly.
	AN4 to AN7		A/D converter analog input pins Set corresponding bit of the ADER to “1”, and corresponding bit of the data register to “1”.
25	P70	F	General-purpose I/O port
	ASR0		Input capture #0 data input pin This pin, as required, is used for input during input capture #0 input operation, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
26	P71	F	General-purpose I/O port
	ASR1		Input capture #1 data input pin This pin, as required, is used for input during input capture #1 input operation, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
27	P72	F	General-purpose I/O port
28	P73	F	General-purpose I/O port
29 to 31	P74 to P76	F	General-purpose I/O port This function is available when outputs of 16-bit timer #0 to #2 are disabled.
	TIN0 to TIN2		16-bit timer input pins These pins, as required are used for input during 16-bit timer #0 to #2 input operation, and it is necessary to disable input/output for other functions from these pins unless such input/output is made intentionally.
	TOT0 to TOT2		16-bit timer output pins This function is available when outputs of 16-bit timer #0 to #2 are enabled.
51 to 53	P82 to P84	I	General-purpose I/O ports This function is available when data outputs of D/A converter #0 to #2 are disabled.
	DAO0 to DAO2		D/A converter output pins This function is available when data outputs of D/A converter #0 to #2 are enabled.

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Pin no.	Pin name	Circuit type	Function
54 to 56	P85 to P87	F	General-purpose I/O ports This function is available when outputs of PWM0 to PWM2 are disabled.
	PWM0 to PWM2		PWM output pins This function is available when outputs of PWM0 to PWM2 are enabled.
57, 58	P90, P91	G	General-purpose I/O ports This function is always valid.
	INT0, INT1		External interrupt input pins These pins, as required, are used for input while external interrupt is enabled, and it is necessary to disable input/output for other functions from these pins unless such input/output is made intentionally.
59	P92	F	General-purpose I/O port This function is always valid.
	INT2		External interrupt input pin This pin, as required, is used for input while external interrupt is enabled, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
	$\overline{ATG}$		A/D converter activation trigger input pin This pin, as required, is used for input while A/D converter is waiting for activation, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
60	P93	F	General-purpose I/O port This function is always valid. This function is available when output of PWM3 is disabled.
	INT3		External interrupt input pin This pin, as required, is used for input while external interrupt is enabled, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
	PWM3		PWM output pin This function is available when output of PWM3 is enabled.
61	P94	F	General-purpose I/O port
	SID0		UART #0 data input pin This pin, as required, is used for input during UART #0 input operation, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
62	P95	F	General-purpose I/O port This function is available when data output of UART #0 is disabled.
	SOD0		UART #0 data output pin This function is available when data output of UART #0 is enabled.
63	P96	F	General-purpose I/O port This function is available when clock output of UART #0 is disabled.
	SCK0		UART #0 clock I/O pin

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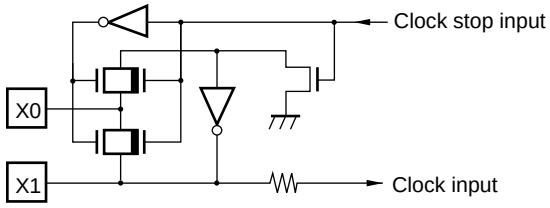
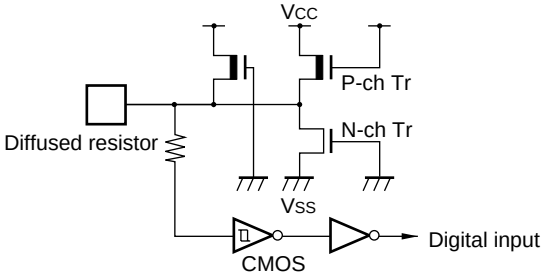
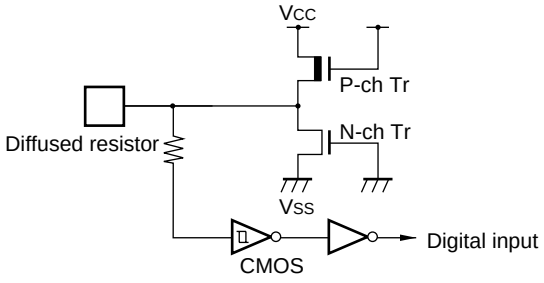
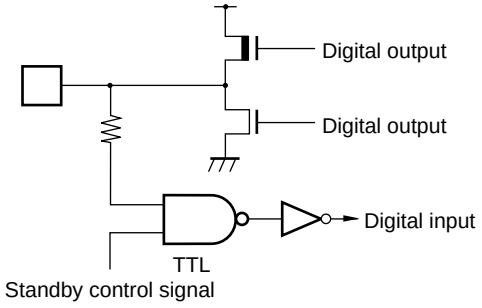
Pin no.	Pin name	Circuit type	Function
64	PA0	F	General-purpose I/O port This function is always valid.
	SID1		SSI #1 data input pin This pin, as required, is used for input during SSI #1 input operation, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
65	PA1	F	General-purpose I/O port This function is available when data output of SSI #1 is disabled.
	SOD1		SSI #1 data output This function is available when data output of SSI #1 is enabled.
66	PA2	F	General-purpose I/O port This function is available when clock output of SSI #1 is disabled.
	SCK1		SSI #1 clock output This function is available when clock output of SSI #1 is enabled.
67	PA3	F	General-purpose I/O port
	SID2		SSI #2 data input pin This pin, as required, is used for input during SSI #2 input operation, and it is necessary to disable input/output for other functions from this pin unless such input/output is made intentionally.
68	PA4	F	General-purpose I/O port This function is available when data output of SSI #2 is disabled.
	SOD2		SSI #2 data output This function is available when data output of SSI #2 is enabled.
69	PA5	F	General-purpose I/O port This function is available when clock output of SSI #2 is disabled.
	SCK2		SSI #2 clock output This function is available when clock output of SSI #2 is enabled.
21, 82	V_{CC}	Power supply	Digital circuit power supply pin
9, 40, 79	V_{SS}	Power supply	Digital circuit ground level
32	AV_{CC}	Power supply	Analog circuit power supply pin This power supply must only be turned on or off when electric potential of AV_{CC} or greater is applied to V_{CC}.
33	AVRH	Power supply	A/D converter external reference voltage input pin. This pin must only be trendy on or off when electric potential of AVRH or greater is applied to AV_{CC}.
34	AVRL	Power supply	A/D converter external reference voltage input pin
45	DVRH	Power supply	D/A converter external reference voltage input pin
46	DVRL	Power supply	D/A converter external reference voltage input pin
35	AV_{SS}	Power supply	Analog circuit ground level

■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A		• 32 MHz • Oscillation feedback resistor: approximately 1 MΩ
B		• CMOS-level hysteresis input Without standby control Pull-up resistor: approximately 50 kΩ
D		• CMOS-level hysteresis input Without standby control
E		• CMOS-level output TTL-level input With standby control

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MB90246A Series

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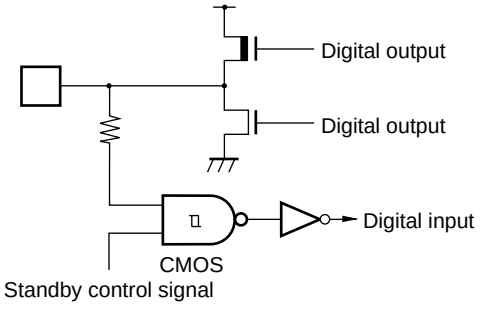
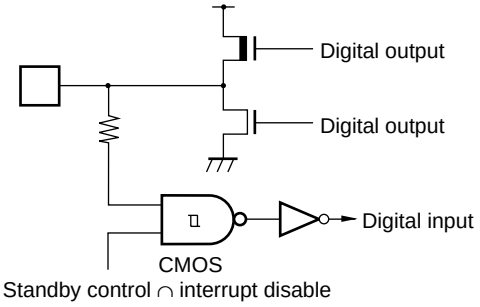
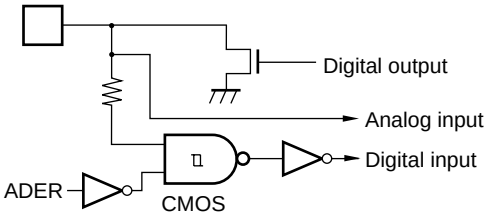
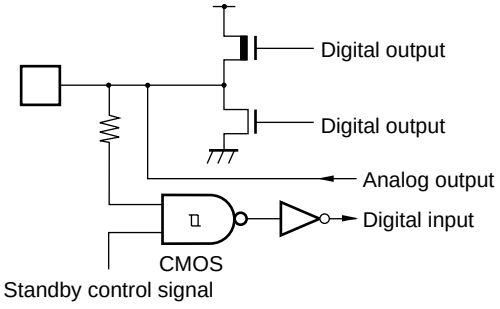
Type	Circuit	Remarks
F		• CMOS-level output CMOS-level hysteresis input With standby control
G		• CMOS-level output CMOS-level hysteresis input With standby control (interrupt disable)
H		• N-ch open-drain CMOS-level output CMOS-level hysteresis input Analog input With analog input control
I		• CMOS-level output Analog input CMOS-level hysteresis input With standby control

■ HANDLING DEVICES

1. Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to the input or output pins other than medium-and high-voltage pins or if higher than the voltage is applied between V_{CC} and V_{SS}.

When latchup occurs, power supply current increases rapidly might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

In addition, for the same reasons take care to prevent the analog power supply from exceeding the digital power supply.

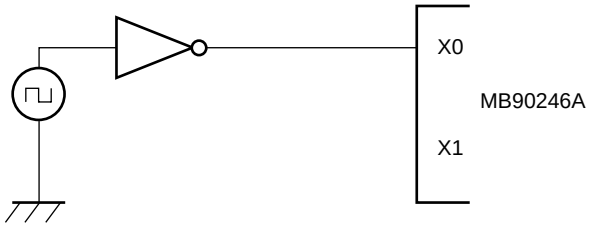
2. Treatment of Unused Pins

Leaving unused input pins open could cause malfunctions. They should be connected to a pull-up or pull-down resistors.

3. Precautions when Using an External Clock

When an external clock is used, drive X0 only and X1 should be left open.

- **Using an External Clock**



4. Power Supply Pins

When there are several V_{CC} and V_{SS} pins, those pins that should have the same electric potential are connected within the device when the device is designed in order to prevent misoperation, such as latchup. However, all of those pins must be connected to the power supply and ground externally in order to reduce unnecessary emissions, prevent misoperation of strobe signals due to an increase in the ground level, and to observe the total output current standards.

In addition, give a due consideration to the connection in that current supply be connected to V_{CC} and V_{SS} with the lowest possible impedance.

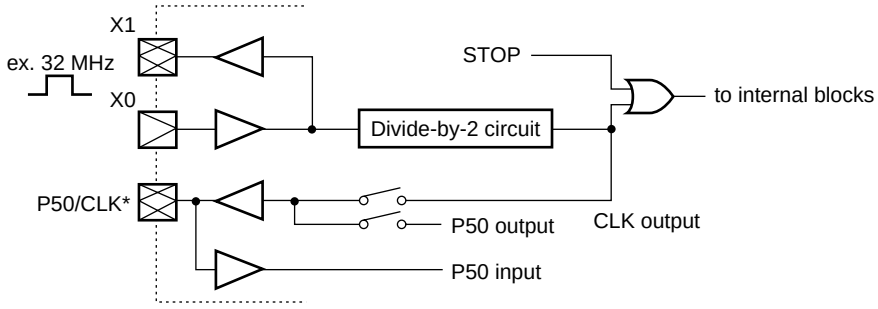
Finally, it is recommended to connect a ceramic capacitor of about 0.1 µF between V_{CC} and V_{SS} near this device as a bypass capacitor.

5. Crystal Oscillation Circuit

Noise in the vicinity of the X0 and X1 pins will cause this device to operate incorrectly. Design the printed circuit board so that the bypass capacitor connecting X0, X1 and the crystal oscillator (or ceramic oscillator) to ground is located as close to the device as possible.

In addition, because printed circuit board artwork in which the area around the X0 and X1 pins is surrounded by ground provides stable operation, such an arrangement is strongly recommended.

6. CLK Pin



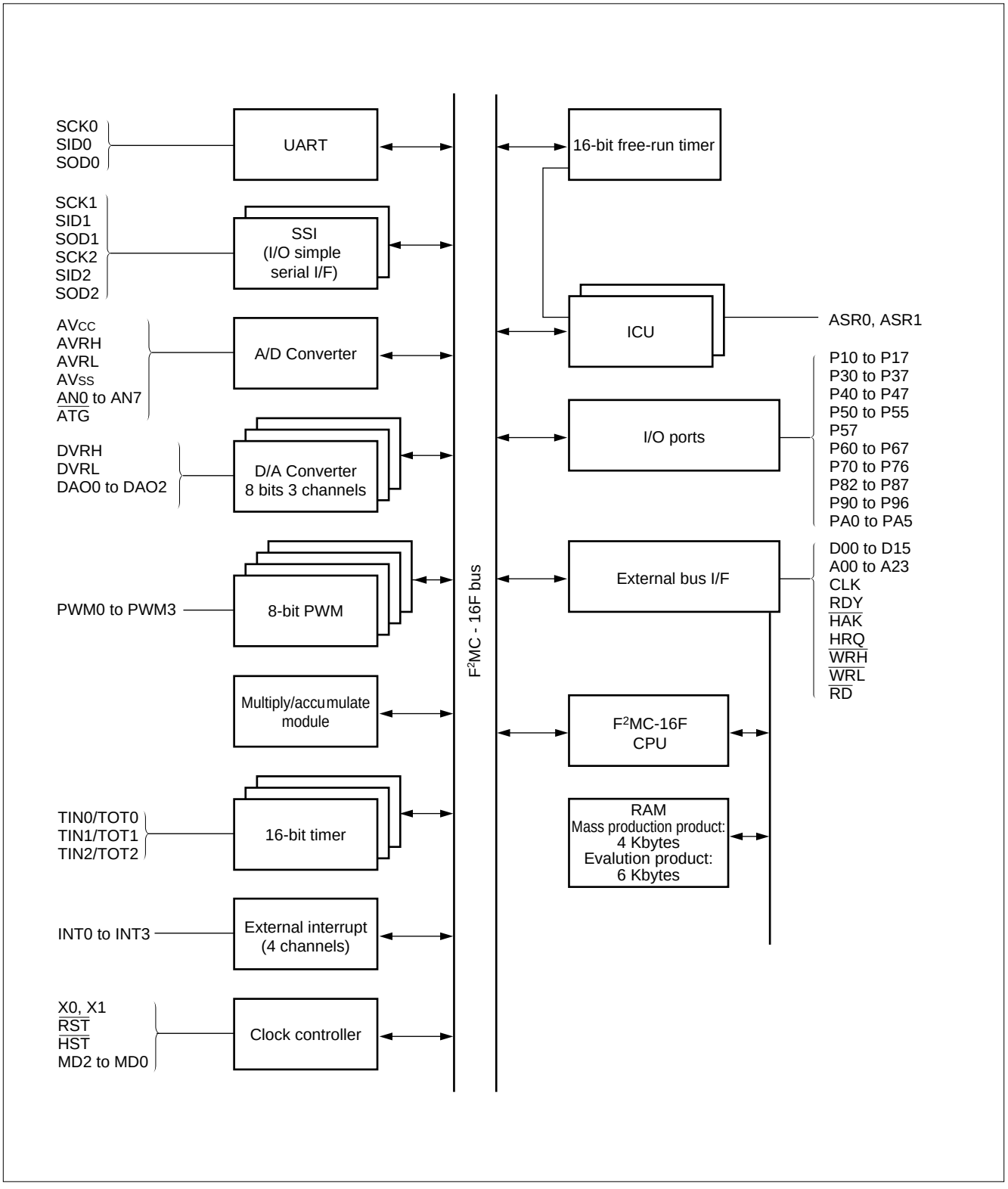
*: In the external bus mode, the P50/CLK pin is initially configured as a CLK output pin.

7. $\overline{\text{HST}}$ Pin

Hold the $\overline{\text{HST}}$ pin to the “H” level when applying power supply.

When inputting the “L” level to the $\overline{\text{HST}}$ pin, make sure that the $\overline{\text{RST}}$ pin is in the “H” level.

■ BLOCK DIAGRAM



■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

(V_{SS} = AV_{SS} = 0.0 V)

Parameter	Pin name	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	V_{CC}	V_{SS} – 0.3	V_{SS} + 7.0	V	
	AV_{CC}	V_{SS} – 0.3	V_{SS} + 7.0	V	
Input voltage	V_I *	V_{SS} – 0.3	V_{CC} + 0.3	V	
Output voltage	V_O *	V_{SS} – 0.3	V_{CC} + 0.3	V	
“L” level output current	I_{OL}	—	10	mA	
“L” level average output current	I_{OLAV}	—	4	mA	
“L” level total average current	ΣI_{OLAV}	—	50	mA	
“H” level output current	I_{OH}	—	–10	mA	
“H” level average output current	I_{OHAV}	—	–4	mA	
“H” level total average current	ΣI_{OHAV}	—	–48	mA	
Power consumption	P_d	—	600	mW	
Operating temperature	T_A	–30	+70	°C	
Storage temperature	T_{stg}	–55	+150	°C	

* : V_I and V_O must not exceed V_{CC} +0.3 V.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

2. Recommended Operating Conditions

(V_{SS} = AV_{SS} = 0.0 V)

Parameter	Pin name	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	V_{CC}	4.5	5.5	V	
		2.0	5.5	V	For retaining RAM data in the stop mode
Storage temperature	T_A	–30	+70	°C	External bus mode

WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device’s electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

3. DC Characteristics

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
"H" level input voltage	V_{IH1}	—	—	0.7 V_{CC}	—	V_{CC} + 0.3	V	CMOS input
	V_{IH2}	—	V_{CC} = 5.0 V ±10%	2.2	—	V_{CC} + 0.3	V	TTL input
	V_{IHIS}	—	—	0.8 V_{CC}	—	V_{CC} + 0.3	V	Hysteresis input
	V_{IHM}	MD0 to MD2	—	V_{CC} – 0.3	—	V_{CC} + 0.3	V	
"L" level input voltage	V_{IL1}	—	—	V_{SS} – 0.3	—	0.3 V_{CC}	V	CMOS input
	V_{IL2}	—	V_{CC} = 5.0 V ±10%	V_{SS} – 0.3	—	0.8	V	TTL input
	V_{ILIS}	—	—	V_{SS} – 0.3	—	0.2 V_{CC}	V	Hysteresis input
	V_{ILM}	MD0 to MD2	—	V_{SS} – 0.3	—	V_{SS} + 0.3	V	
"H" level output voltage	V_{OH}	All ports except P60 to P67	V_{CC} = 4.5 V I_{OH} = –4.0 mA	V_{CC} – 0.5	—	—	V	
"L" level output voltage	V_{OL}	All ports	V_{CC} = 4.5 V I_{OL} = 4.0 mA	—	—	0.4	V	
"H" level input current	I_{IH1}	Except $\overline{RST}$	V_{CC} = 5.5 V V_{IH} = 0.7 V_{CC}	—	—	–10	µA	CMOS input
	I_{IH2}	—	V_{CC} = 5.5 V V_{IH} = 2.2 V	—	—	–10	µA	TTL input
	I_{IH3}	—	V_{CC} = 5.5 V V_{IH} = 0.8 V_{CC}	—	—	–10	µA	Hysteresis input
"L" level input current	I_{IL1}	Except $\overline{RST}$	V_{CC} = 5.5 V V_{IL} = 0.3 V_{CC}	—	—	10	µA	CMOS input
	I_{IL2}	—	V_{CC} = 5.5 V V_{IL} = 0.8 V_{CC}	—	—	10	µA	TTL input
	I_{IL3}	—	V_{CC} = 5.5 V V_{IL} = 0.2 V_{CC}	—	—	10	µA	Hysteresis input
Pull-up resistance	R_{PULL}	$\overline{RST}$	—	22	—	110	kΩ	
Power supply current	I_{CC}	V_{CC}	V_{CC} = 5.0 V ±10% F_C = 32 MHz	—	80	100	mA	At operation
	I_{CCS}	V_{CC}	V_{CC} = 5.0 V ±10% F_C = 32 MHz In sleep mode	—	30	50	mA	
	I_{CCH}	V_{CC}	V_{CC} = 4.5 V to 5.5 V T_A = +25°C In stop mode	—	0.1	10	µA	
Input capacitance	C_{IN}	Except V_{CC}, V_{SS}	—	—	10	—	pF	
Open-drain output leakage current	I_{LEAK}	P60 to P67	—	—	0.1	10	µA	

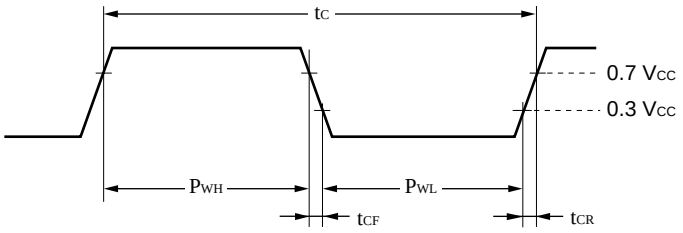
4. AC Characteristics

(1) Clock Timing

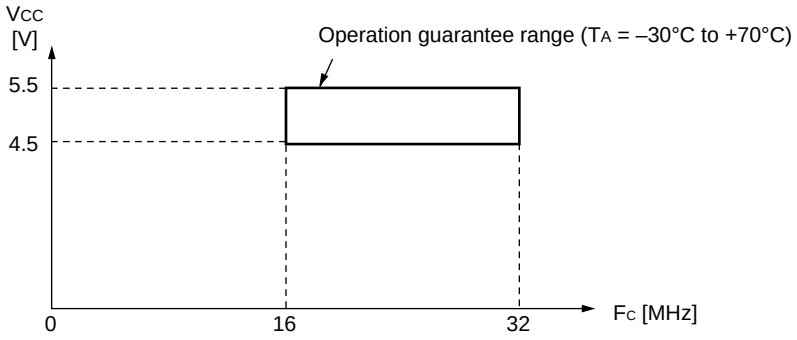
(V_{CC} = +4.5 V to +5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Clock frequency	F_C	X0 X1	V_{CC} = 5.0 V ±10%	16	32	MHz	
Clock cycle time	t_C	X0 X1	—	1/F_C	—	ns	
Input clock pulse width	P_{WH} P_{WL}	X0	V_{CC} = 5.0 V ±10%	10	—	ns	
Input clock rising/ falling time	t_{CR} t_{CF}	X0	V_{CC} = 5.0 V ±10%	—	11	ns	Value (max.) = t_{CR} + t_{CF}

- **Clock Timing**



- **Relationship between Clock Frequency and Supply Voltage**

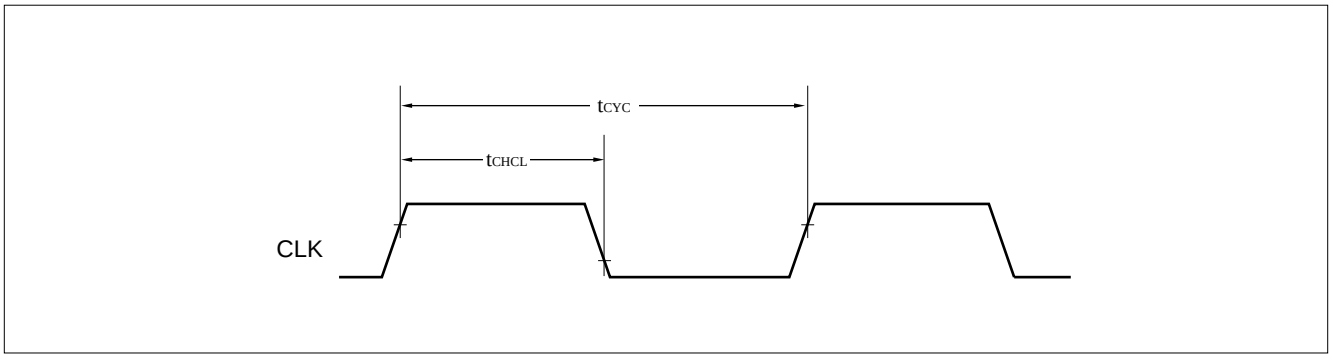


(2) Clock Output Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Cycle time (Machine cycle)	t_{CYC}	CLK	—	$t_C \times 2$	$t_C \times 32$*	ns	
CLK ↑ → CLK↓	t_{CHCL}	CLK	V_{CC} = 5.0 V ±10%	$t_{CYC}/2 - 20$	$t_{CYC}/2 + 20$	ns	

* : For a clock frequency (Fc) of 16 MHz and the lowest speed (divide-by-16) is selected in the clock gear function.

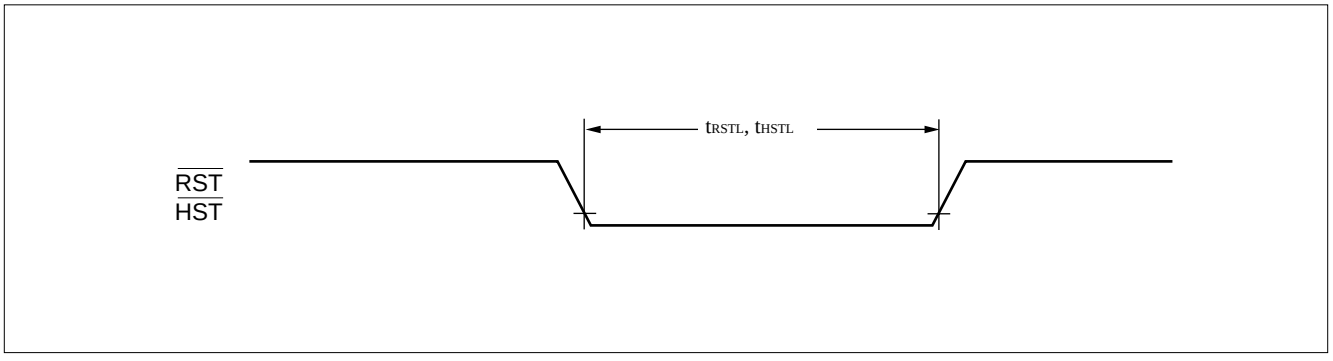


(3) Reset and Hardware Standby Input Standards

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Reset input time	t_{RSTL}	$\overline{RST}$	—	$t_{CYC} \times 5$	—	ns	
Hardware standby input time	t_{HSTL}	$\overline{HST}$	—	$t_{CYC} \times 5$	—	ns	

Note: The machine cycle time at hardware standby is set to 1/32 divided oscillation.

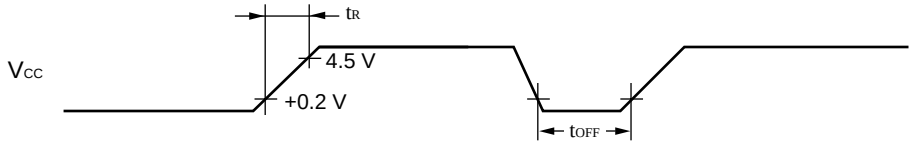


(4) Power-on Reset

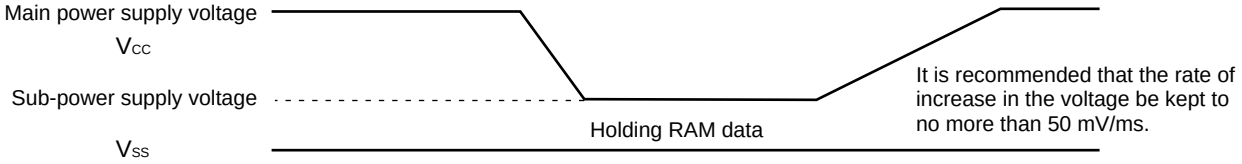
(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Power supply rising time	t_R	V_{CC}	—	—	30	ms	V_{CC} must be lower than 0.2 V before power is applied.
Power supply shut down time	t_{OFF}	V_{CC}	—	1	—	ms	

Notes: • The above specifications are the values needed in order to activate a power-on reset.
• When $\overline{HST}$ = "L", be sure to turn on the power in accordance with these standards and apply a power-on reset, regardless of whether a power-on reset is needed or not.
• Some of the on-chip registers (STBYC, etc.) in a device are initialized only by a power-on reset. In order to initialize these registers, it is necessary to apply power in accordance with these standards.



If power supply voltage needs to be changed in the course of operation, a smooth voltage rise is recommended by suppressing the voltage variation as shown below.

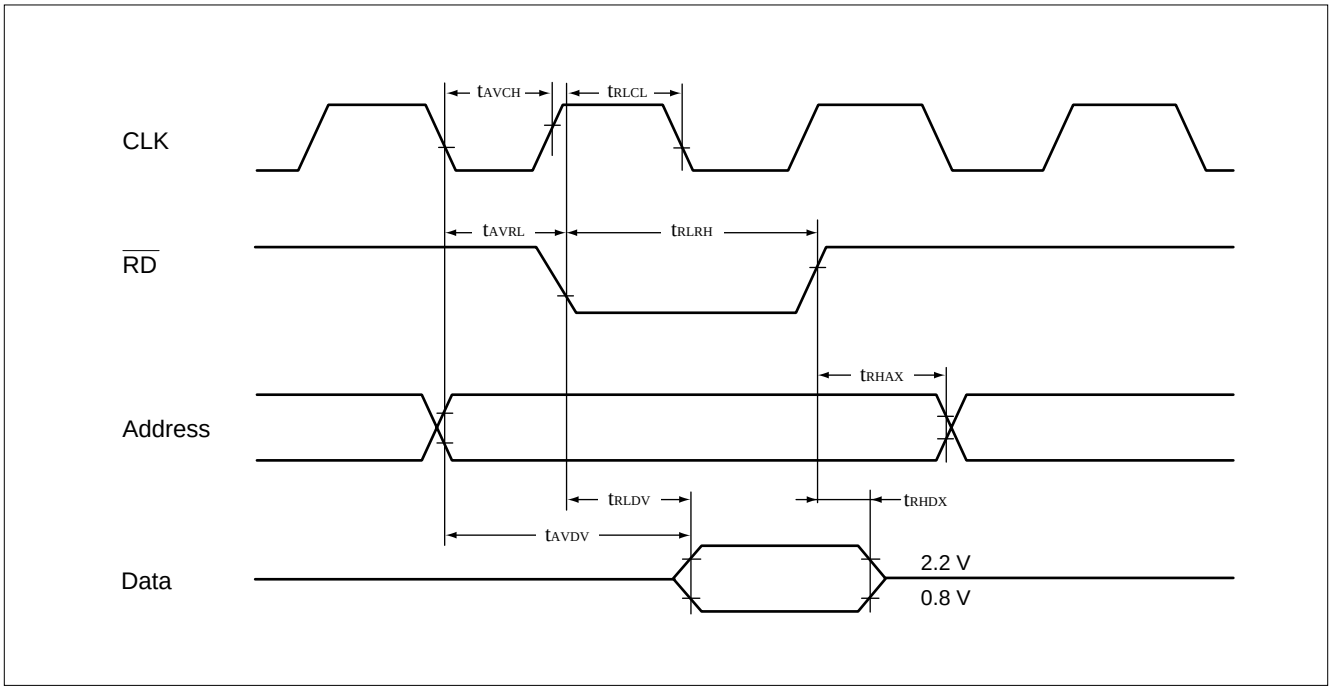


(5) Bus Timing (Read)

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Valid address → $\overline{RD}$ ↓ time	t_{AVRL}	Address	V_{CC} = 5.0 V ±10%	$t_{CYC}/2 - 20$	—	ns	
$\overline{RD}$ pulse width	t_{RLRH}	$\overline{RD}$	—	$(N + 1) \times t_{CYC} - 25$	—	ns	
$\overline{RD}$ ↓ → Valid data input	t_{RLDV}	D15 to D00	V_{CC} = 5.0 V ±10%	—	$(N + 1) \times t_{CYC} - 30$	ns	
$\overline{RD}$ ↑ → Data hold time	t_{RHDX}	D15 to D00	—	0	—	ns	
Valid address → Valid data input	t_{AVDV}	D15 to D00	V_{CC} = 5.0 V ±10%	—	$(N + 1.5) \times t_{CYC} - 40$	ns	
$\overline{RD}$ ↑ → Address invalid time	t_{RHAX}	Address	—	$t_{CYC}/2 - 20$	—	ns	
Valid address → CLK ↑ time	t_{AVCH}	Address CLK	—	$t_{CYC}/2 - 25$	—	ns	
$\overline{RD}$ ↓ → CLK ↓ time	t_{RLCL}	$\overline{RD}$ CLK	—	$t_{CYC}/2 - 25$	—	ns	

Note: Number of wait cycles. If no waits inserted, the N is set to “0.” (Number of waits are given by the automatic wait insertion function and external RDY signal.)

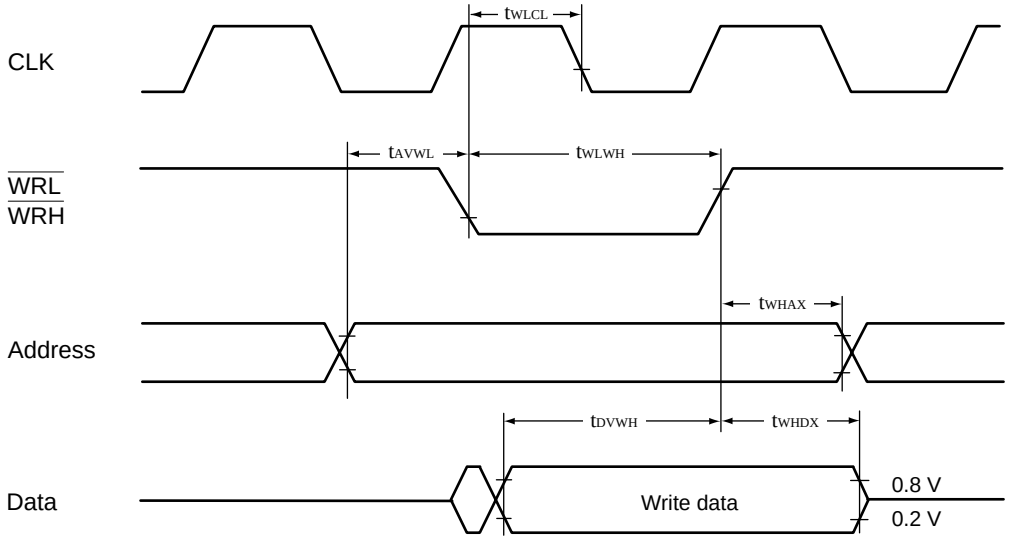


(6) Bus Timing (Write)

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Valid address → $\overline{WRL}$, $\overline{WRH}$ ↓ time	t_{AVWL}	Address	V_{CC} = 5.0 V ±10%	$t_{CYC}/2 - 20$	—	ns	
$\overline{WRL}$, $\overline{WRH}$ pulse width	t_{WLWH}	$\overline{WRL}$ $\overline{WRH}$	—	$(N + 1) \times t_{CYC} - 25$	—	ns	
Valid data output → $\overline{WRL}$, $\overline{WRH}$ ↑ time	t_{DVWH}	D15 to D00	—	$(N + 1) \times t_{CYC} - 40$	—	ns	
$\overline{WRL}$, $\overline{WRH}$ ↑ → Data hold time	t_{WHDX}	D15 to D00	V_{CC} = 5.0 V ±10%	$t_{CYC}/2 - 20$	—	ns	
$\overline{WRL}$, $\overline{WRH}$ ↑ → Address invalid time	t_{WHAX}	Address	—	$t_{CYC}/2 - 20$	—	ns	
$\overline{WRL}$, $\overline{WRH}$ ↓ → CLK ↓ time	t_{WLCL}	$\overline{WRL}$ $\overline{WRH}$ CLK	—	$t_{CYC}/2 - 25$	—	ns	

Note: Number of wait cycles. If no waits inserted, the N is set to “0.” (Number of waits are given by the automatic wait insertion function and external RDY signal.)



(7) Ready Input Timing

- **Ratings Based on CLK Signal**

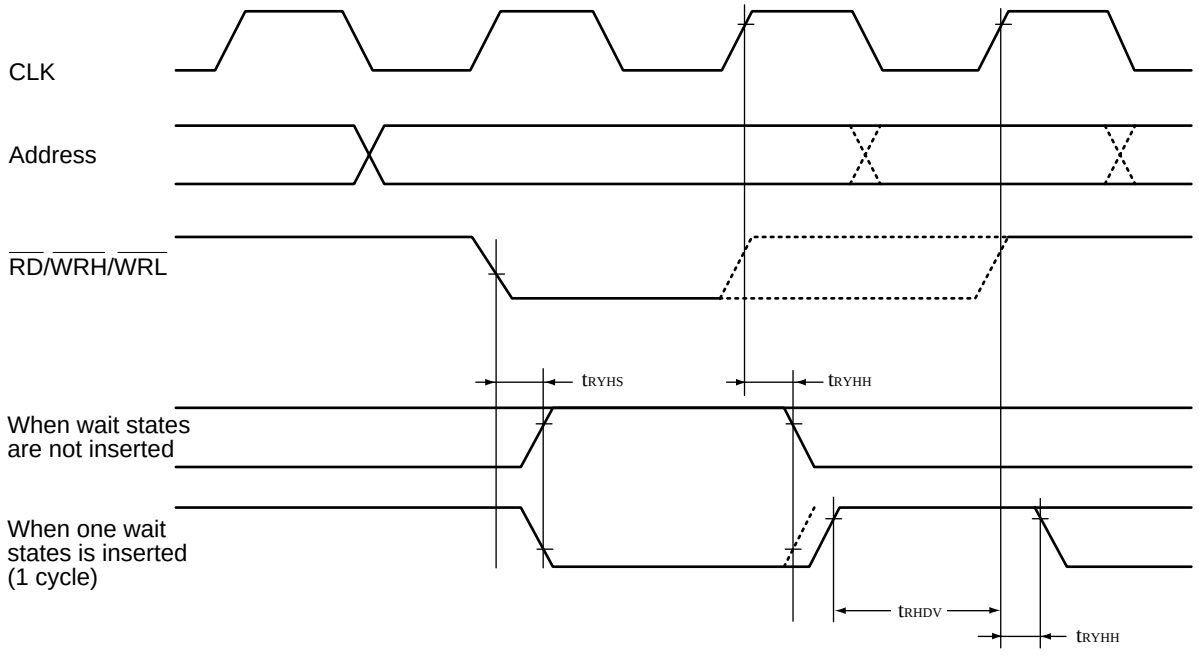
(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
$\overline{RD}/\overline{WRH}/\overline{WRL}$ ↓ → RDY ↓ time	t_{RYHS}	$\overline{RD}/\overline{WRH}/\overline{WRL}$ RDY	—	0	n × t_{CYC} + 15	ns	
RDY set up time (When disabled)	t_{RHDV}	RDY	—	30	—	ns	
RDY hold time	t_{RYHH}	RDY	—	0	—	ns	

n: Number of wait cycles inserted automatically. n is set to “0” when no wait cycles are inserted automatically.

Note: If the setup time during the fall of RDY is insufficient, use the auto ready function.

- **Ready Input Timing (Based on CLK Signal)**



- **Ratings Based on RD/WRH/WRL Signals**

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

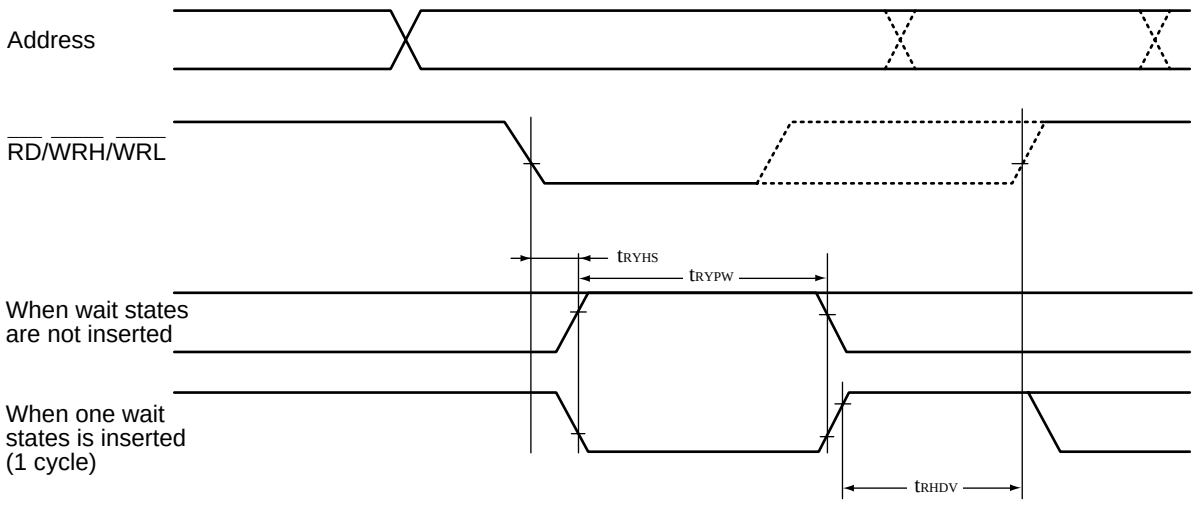
Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
$\overline{RD}/\overline{WRH}/\overline{WRL}$ ↓ → RDY ↓ time	t_{RYHS}	$\overline{RD}/\overline{WRH}/\overline{WRL}$ RDY	—	0	n × t_{CYC} + 15 *1	ns	
RDY pulse width	t_{RYPW}	RDY	V_{CC} = 5.0 V ±10%	1/2 t_{CYC} + 20	(m + 1) × t_{CYC} *2	ns	
RDY ↑ → $\overline{RD}$ ↑	t_{RHDV}	$\overline{RD}/\overline{WRH}/\overline{WRL}$ RDY	—	t_{CYC} – 15	2 t_{CYC} – 25	ns	

n: Number of wait cycles inserted automatically. n is set to “0” when no wait cycles are inserted automatically.

m: Number of wait cycles inserted by the RDY signal. If no waits inserted the m is set to “0.”

*1: If the setup time during the fall of RDY is insufficient, use the auto ready function.
*2: If the pulse width exceeds the maximum value, the wait time is extended by one cycle from the specified value.

- **Ready Input Timing (Based on RD/WRH/WRL Signals)**

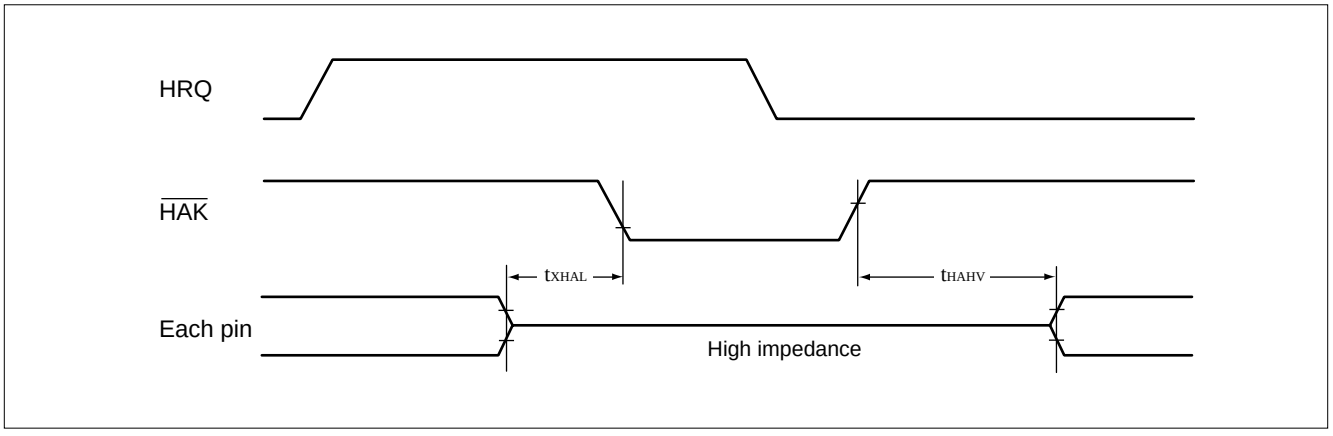


(8) Hold Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Pin floating → $\overline{HAK}$ ↓ time	t_{XHAL}	$\overline{HAK}$	V_{CC} = 5.0 V ±10%	30	t_{CYC}	ns	
$\overline{HAK}$ ↑ time → Pin valid time	t_{HAHV}	$\overline{HAK}$	—	t_{CYC}	2 t_{CYC}	ns	

Note: At least one cycle is required from the time when HRQ is fetched until $\overline{HAK}$ changes.



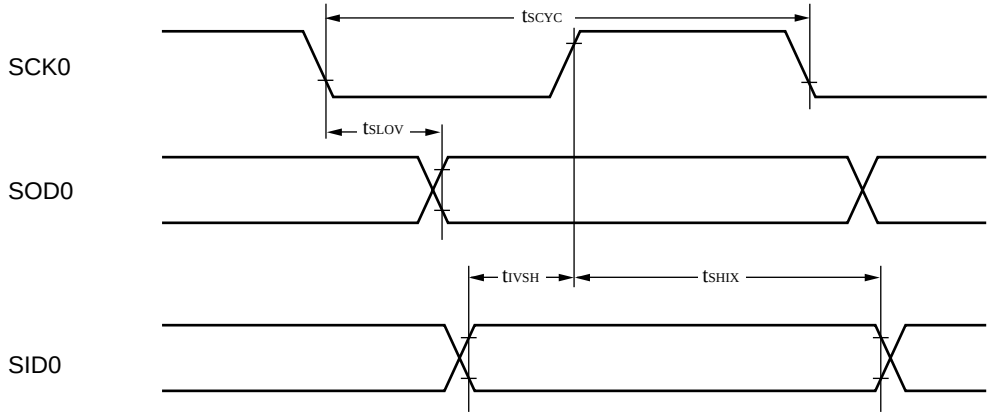
(9) UART Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

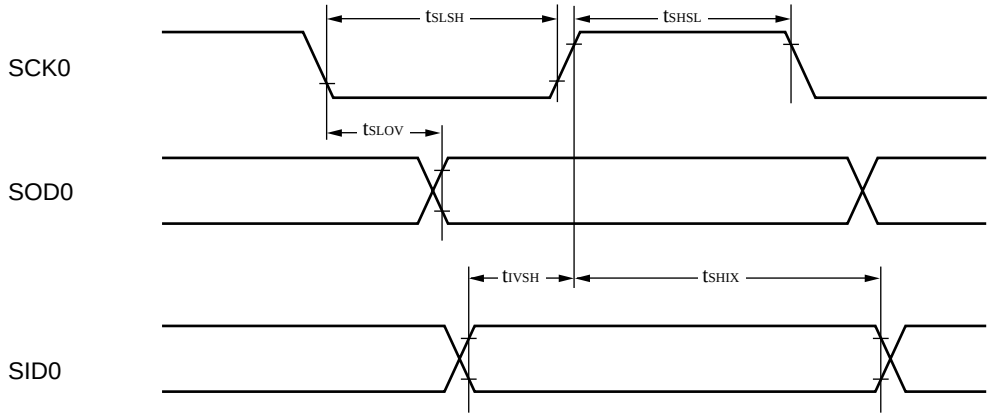
Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Serial clock cycle time	t_{SCYC}	SCK0	—	8 t_{CYC}	—	ns	For internal shift clock mode output pin, C_L = 80 pF
SCK ↓ → SOD delay time	t_{SLOV}	SCK0 SOD0	V_{CC} = 5.0 V ±10%	–80	80	ns	
Valid SID → SCK ↑	t_{IVSH}	SCK0 SID0	V_{CC} = 5.0 V ±10%	100	—	ns	
SCK ↑ → Valid SID hold time	t_{SHIX}	SCK0 SID0	V_{CC} = 5.0 V ±10%	60	—	ns	
Serial clock “H” pulse width	t_{SHSL}	SCK0	—	4 t_{CYC}	—	ns	For external shift clock mode output pin, C_L = 80 pF
Serial clock “L” pulse width	t_{SLSH}	SCK0	—	4 t_{CYC}	—	ns	
SCK ↓ → SOD delay time	t_{SLOV}	SCK0 SOD0	V_{CC} = 5.0 V ±10%	—	150	ns	
Valid SID → SCK ↑	t_{IVSH}	SCK0 SID0	V_{CC} = 5.0 V ±10%	60	—	ns	
SCK ↑ → Valid SID hold time	t_{SHIX}	SCK0 SID0	V_{CC} = 5.0 V ±10%	60	—	ns	

Notes: • These are the AC characteristics for CLK synchronous mode.
• C_L is the load capacitance added to pins during testing.

- **Internal Shift Clock Mode**



- **External Shift Clock Mode**



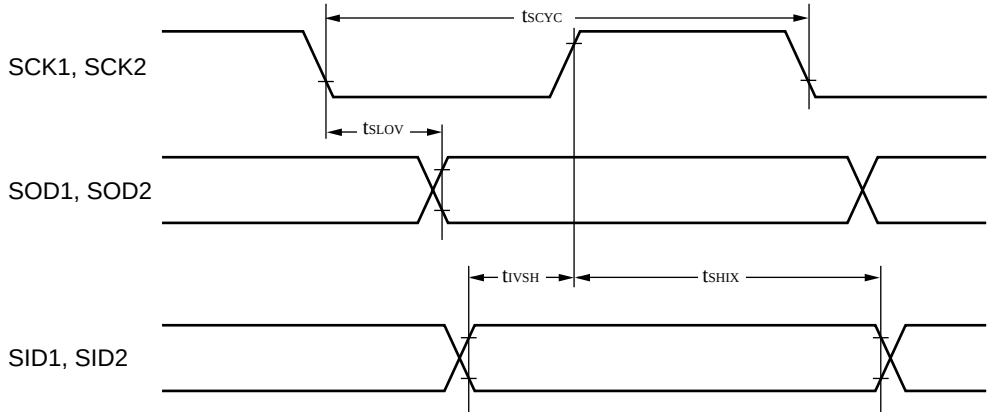
(10) SSI Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Serial clock cycle time	t_{SCYC}	SCK1, SCK2	—	2 t_{CYC}	—	ns	For internal shift clock mode output pin, C_L = 80 pF
SCK ↓ → SOD delay time	t_{SLOV}	SCK1, SOD1 SCK2, SOD2	—	—	t_{CYC}/2	ns	
Valid SID → SCK ↑	t_{IVSH}	SCK1, SID1 SCK2, SID2	—	1 t_{CYC}	—	ns	
SCK ↑ → Valid SID hold time	t_{SHIX}	SCK1, SID1 SCK2, SID2	—	1 t_{CYC}	—	ns	

Note: C_L is the load capacitance added to pins during testing.

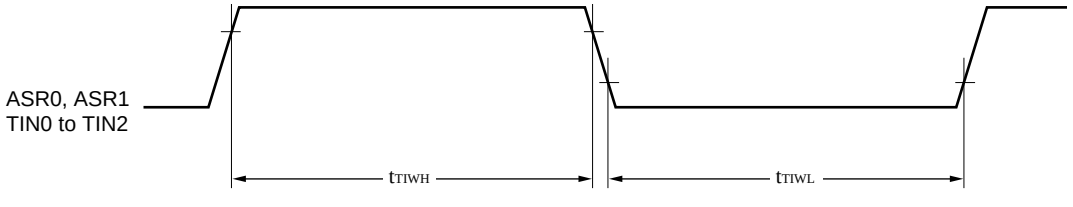
- **Internal Shift Clock Mode**



(11) Timer Input Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

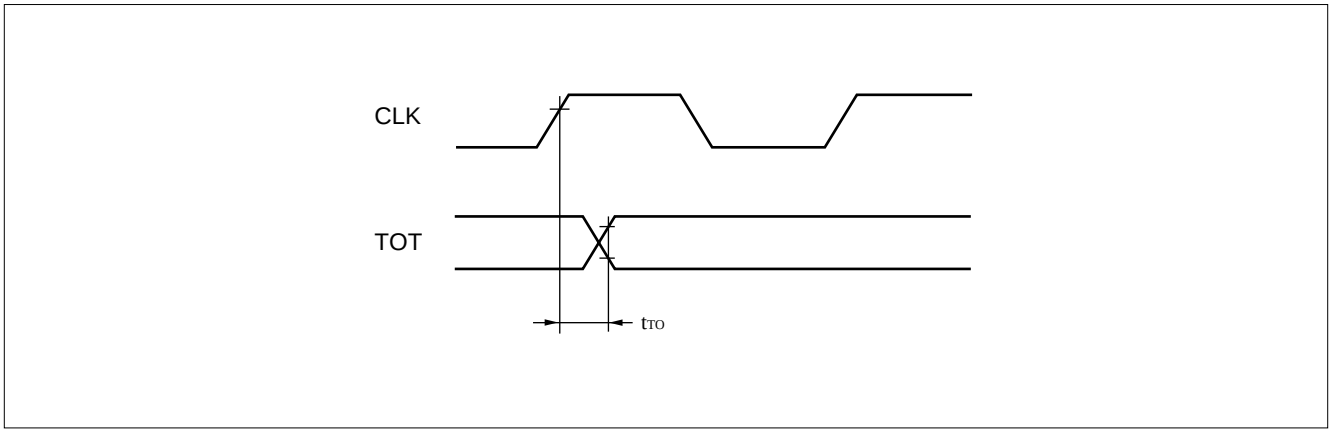
Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Input pulse width	t_{TIWH} t_{TIWL}	ASR0, ASR1 TIN0 to TIN2	—	4 t_{CYC}	—	ns	



(12) Timer Output Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

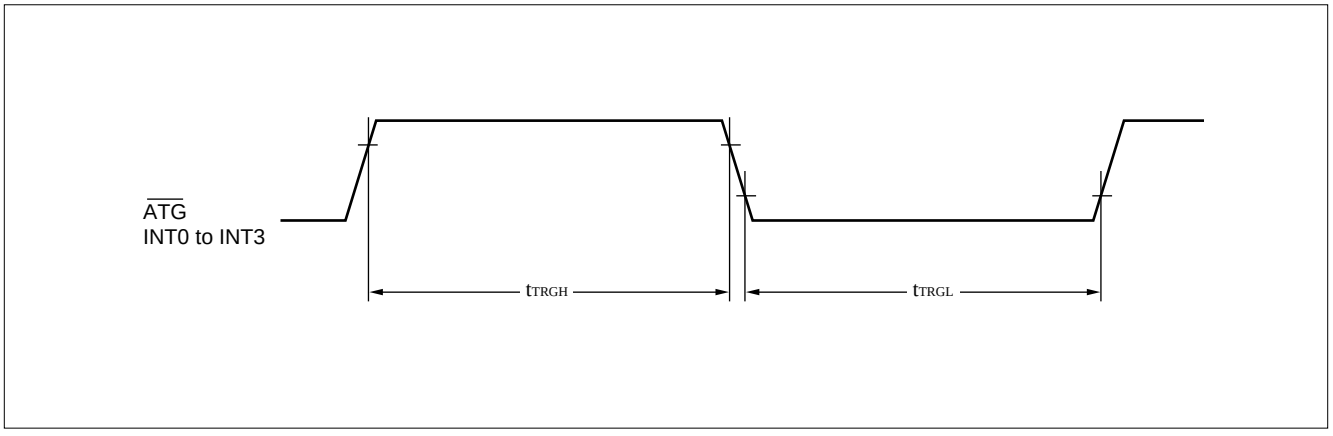
Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
CLK ↑ → Change time	t_{TO}	TOT0 to TOT2 PWM0 to PWM3	V_{CC} = 5.0 V ±10%	—	40	ns	



(13) Trigger Input Timing

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Input pulse width	t_{TRGH} t_{TRGL}	$\overline{ATG}$ INT0 to INT3	—	5 t_{CYC}	—	ns	

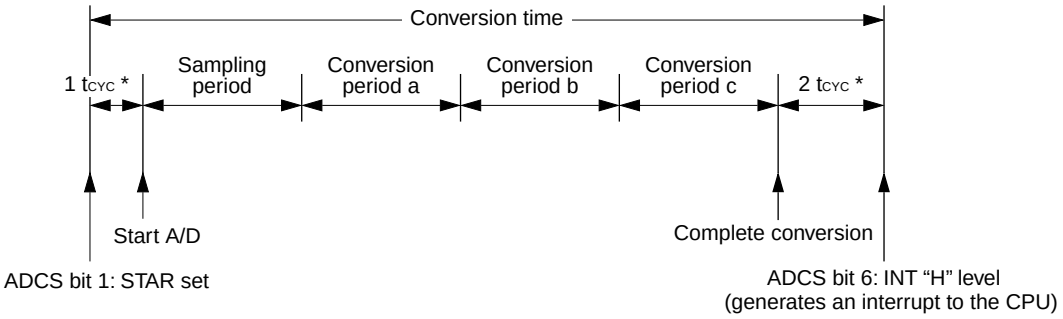


5. A/D Converter Electrical Characteristics

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = –30°C to +70°C)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min.	Typ.	Max.		
Resolution	—	—	—	8, 10	10	bit	
Total error	—	—	—	—	±3.0	LSB	
Linearity error	—	—	—	—	±2.0	LSB	
Differential linearity error	—	—	—	—	±1.9	LSB	
Zero transition voltage	V_{0t}	AN0 to AN7	AVRL – 1.0	AVRL + 1.0	AVRL + 3.0	LSB	
Full-scale transition voltage	V_{FST}	AN0 to AN7	AVRH – 4.0	AVRH – 1.0	AVRH + 1.0	LSB	
Conversion time *1	—	—	1.25	—	—	µs	Specified by the ADCT register settings. V_{CC} = 5.0 V ±10%
Sampling period	—	—	560	—	—	ns	
Conversion period a	—	—	125	—	—	ns	
Conversion period b	—	—	125	—	—	ns	
Conversion period c	—	—	250	—	—	ns	
Analog input voltage	—	AN0 to AN7	AVRL	—	AVRH	V	
Reference voltage	—	AVRH	AVRL + 2.7	—	AV_{CC}	V	AVRH – AVRL ≥ 2.7
	—	AVRL	0	—	AVRH – 2.7	V	
Power supply current	I_A	AV_{CC}	—	15	20	mA	
	I_{AS} *2		—	—	5	µA	AV_{CC} = 5.5 V in stop mode
Reference voltage supply current	I_R	AVRH	—	0.7	2	mA	
	I_{RS} *2		—	—	5	µA	AV_{CC} = 5.5 V in stop mode
Analog port input current	I_{AIN}	AN0 to AN7	—	0.1	3	µA	
Interchannel disparity	—	AN0 to AN7	—	—	4	LSB	

*1: Definitions of terms in the “conversion time” section

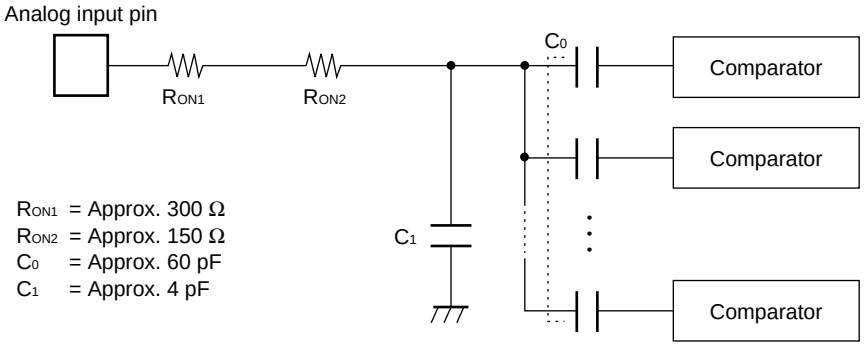


For the t_{CVC}, refer to the “cycle time” in ■ ELECTRICAL CHARACTERISTICS, 4. AC Characteristics, (2) Clock Output Timing.

*2: Current when the A/D converter is not operating and the CPU is stopped.

Notes: • The smaller | AVRH – AVRL |, the greater the error would become relatively.
• If the output impedance of the external circuit is high, a sampling time might be insufficient. If the sampling period is set close to the minimum value, the output impedance of external circuits should be lower than 300 Ω approx.

- **Analog Input Circuit Model Diagram**



Note: Use the values shown as guides only.

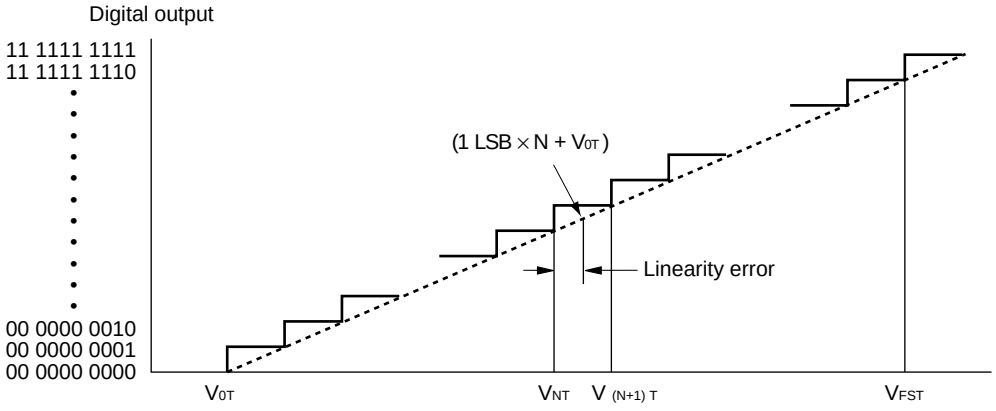
6. A/D Converter Glossary

Resolution: Analog changes that are identifiable with the A/D converter.
When the number of bits is 10, analog voltage can be divided into 2^{10} = 1024

Total error: Difference between actual and logical values. This error is caused by a zero transition error, full-scale transition error, non-linearity error, differential linearity error, or by noise.

Linearity error: The deviation of the straight line connecting the zero transition point (“00 0000 0000” ↔ “00 0000 0001”) with the full-scale transition point (“11 1111 1111” ↔ “11 1111 1110”) from actual conversion characteristics

Differential linearity error: The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value



$$1\ \text{LSB} = \frac{V_{FST} - V_{0T}}{1022}$$

$$\text{Linearity error} = \frac{V_{NT} - (1\ \text{LSB} \times N + V_{0T})}{1\ \text{LSB}}\ \text{(LSB)}$$

$$\text{Differential linearity error} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\ \text{(LSB)}$$

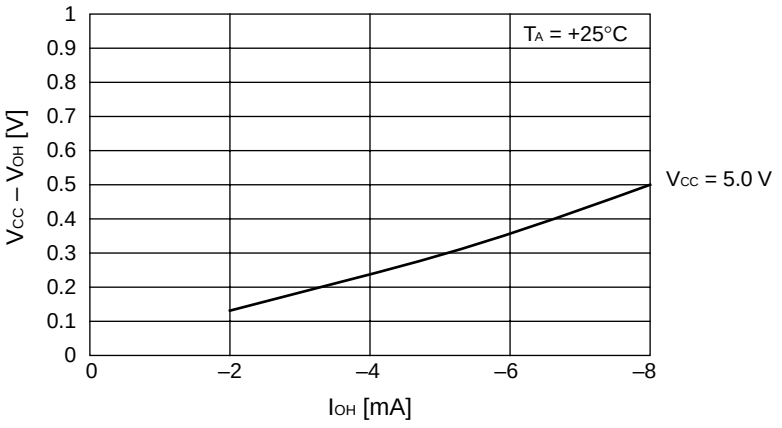
7. 8-bit D/A Converter Electrical Characteristics

(V_{CC} = +4.5 V to +5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = –30°C to +70°C)

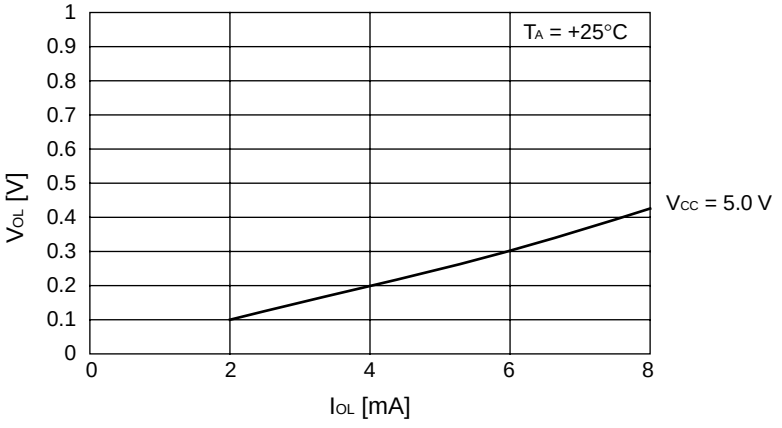
Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min.	Typ.	Max.		
Resolution	—	—	—	8	8	bit	
Differential linearity error	—	—	—	—	±0.9	LSB	
Absolute accuracy	—	—	—	—	1.2	%	V_{CC} = DVRH = 5.0 V, DVRL = 0.0 V
Conversion time	—	—	—	10.0	20.0	µs	The load capacitance = 20 pF
Analog supply voltage	—	DVRH	V_{SS} + 2.0	—	V_{CC}	V	DVRH – DVRL ≥ 2.0 V
	—	DVRL	V_{SS}	—	V_{CC} – 2.0	V	DVRH – DVRL ≥ 2.0 V
Reference voltage supply current	ID	DVRH	—	1.0	1.5	mA	During conversion
	IDH		—	—	10	µA	While in “STOP” status
Analog output impedance	—	—	—	28	—	kΩ	

■ EXAMPLE CHARACTERISTICS

"H" level output voltage
$V_{OH} - I_{OH}$



"L" level output voltage
$V_{OL} - I_{OL}$

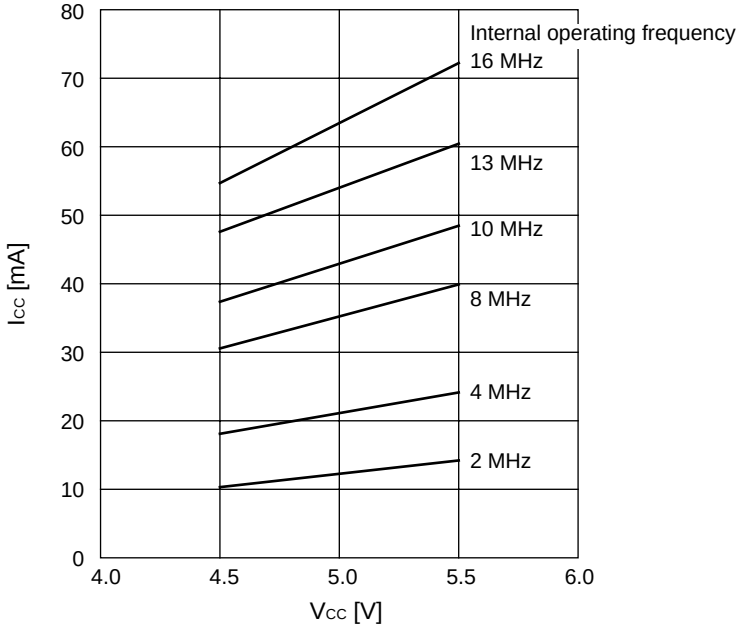


(Continued)

(Continued)

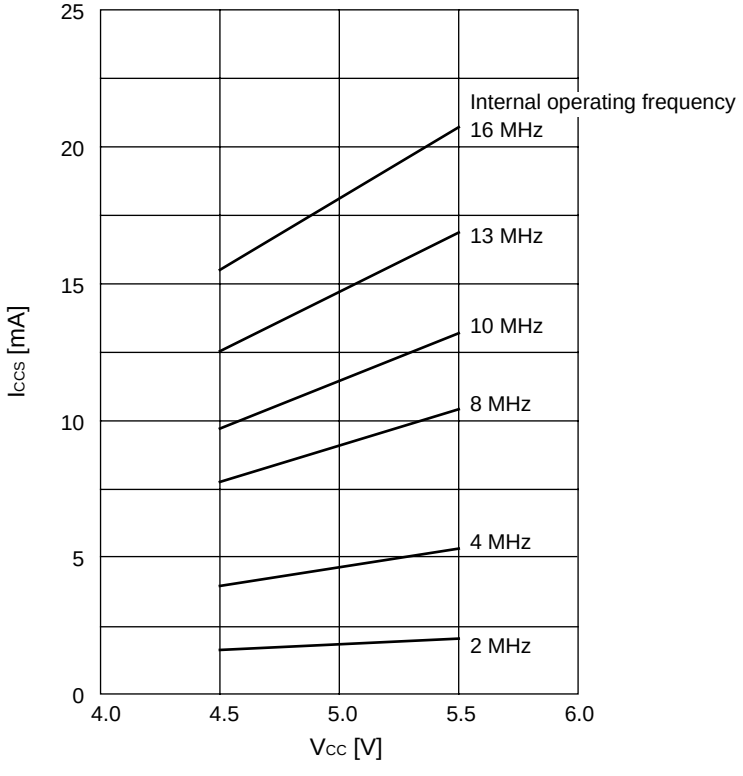
Power supply current

$I_{CC} – V_{CC}$



Power supply current

$I_{CCS} – V_{CC}$



■ INSTRUCTION SET (412 INSTRUCTIONS)

Table 1 Explanation of Items in Table of Instructions

Item	Explanation
Mnemonic	Upper-case letters and symbols: Represented as they appear in assembler Lower-case letters: Replaced when described in assembler. Numbers after lower-case letters: Indicate the bit width within the instruction.
#	Indicates the number of bytes.
~	Indicates the number of cycles. See Table 4 for details about meanings of letters in items.
B	Indicates the correction value for calculating the number of actual cycles during execution of instruction. The number of actual cycles during execution of instruction is summed with the value in the “cycles” column.
Operation	Indicates operation of instruction.
LH	Indicates special operations involving the bits 15 through 08 of the accumulator. Z: Transfers “0”. X: Extends before transferring. —: Transfers nothing.
AH	Indicates special operations involving the high-order 16 bits in the accumulator. *: Transfers from AL to AH. —: No transfer. Z: Transfers 00_H to AH. X: Transfers 00_H or FF_H to AH by extending AL.
I	Indicates the status of each of the following flags: I (interrupt enable), S (stack), T (sticky bit), N (negative), Z (zero), V (overflow), and C (carry). *: Changes due to execution of instruction. —: No change. S: Set by execution of instruction. R: Reset by execution of instruction.
S	
T	
N	
Z	
V	
C	
RMW	Indicates whether the instruction is a read-modify-write instruction (a single instruction that reads data from memory, etc., processes the data, and then writes the result to memory.). *: Instruction is a read-modify-write instruction —: Instruction is not a read-modify-write instruction Note: Cannot be used for addresses that have different meanings depending on whether they are read or written.

Table 2 Explanation of Symbols in Table of Instructions

Symbol	Explanation
A	32-bit accumulator The number of bits used varies according to the instruction. Byte: Low order 8 bits of AL Word: 16 bits of AL Long: 32 bits of AL, AH
AH	High-order 16 bits of A
AL	Low-order 16 bits of A
SP	Stack pointer (USP or SSP)
PC	Program counter
SPCU	Stack pointer upper limit register
SPCL	Stack pointer lower limit register
PCB	Program bank register
DTB	Data bank register
ADB	Additional data bank register
SSB	System stack bank register
USB	User stack bank register
SPB	Current stack bank register (SSB or USB)
DPR	Direct page register
brg1	DTB, ADB, SSB, USB, DPR, PCB, SPB
brg2	DTB, ADB, SSB, USB, DPR, SPB
Ri	R0, R1, R2, R3, R4, R5, R6, R7
RWi	RW0, RW1, RW2, RW3, RW4, RW5, RW6, RW7
RWj	RW0, RW1, RW2, RW3
RLi	RL0, RL1, RL2, RL3
dir addr16 addr24 addr24 0 to 15 addr24 16 to 23	Compact direct addressing Direct addressing Physical direct addressing Bits 0 to 15 of addr24 Bits 16 to 23 of addr24
io	I/O area (000000_H to $0000FF_H$)

(Continued)

(Continued)

Symbol	Explanation
#imm4 #imm8 #imm16 #imm32 ext (imm8)	4-bit immediate data 8-bit immediate data 16-bit immediate data 32-bit immediate data 16-bit data signed and extended from 8-bit immediate data
disp8 disp16	8-bit displacement 16-bit displacement
bp	Bit offset value
vct4 vct8	Vector number (0 to 15) Vector number (0 to 255)
( )b	Bit address
rel ear eam	Branch specification relative to PC Effective addressing (codes 00 to 07) Effective addressing (codes 08 to 1F)
rlst	Register list

Table 3 Effective Address Fields

Code	Notation	Address format	Number of bytes in address extemsion*
00 01 02 03 04 05 06 07	R0 RW0 RL0 R1 RW1 (RL0) R2 RW2 RL1 R3 RW3 (RL1) R4 RW4 RL2 R5 RW5 (RL2) R6 RW6 RL3 R7 RW7 (RL3)	Register direct “ea” corresponds to byte, word, and long-word types, starting from the left	—
08 09 0A 0B	@RW0 @RW1 @RW2 @RW3	Register indirect	0
0C 0D 0E 0F	@RW0 + @RW1 + @RW2 + @RW3 +	Register indirect with post-increment	0
10 11 12 13 14 15 16 17	@RW0 + disp8 @RW1 + disp8 @RW2 + disp8 @RW3 + disp8 @RW4 + disp8 @RW5 + disp8 @RW6 + disp8 @RW7 + disp8	Register indirect with 8-bit displacement	1
18 19 1A 1B	@RW0 + disp16 @RW1 + disp16 @RW2 + disp16 @RW3 + disp16	Register indirect with 16-bit displacemen	2
1C 1D 1E 1F	@RW0 + RW7 @RW1 + RW7 @PC + dip16 addr16	Register indirect with index Register indirect with index PC indirect with 16-bit displacement Direct address	0 0 2 2

* : The number of bytes for address extension is indicated by the “+” symbol in the “#” (number of bytes) column in the Table of Instructions.

Table 4 Number of Execution Cycles for Each Form of Addressing

Code	Operand	(a)*
		Number of execution cycles for each from of addressing
00 to 07	Ri RWi RLi	Listed in Table of Instructions
08 to 0B	@RWj	1
0C to 0F	@RWj +	4
10 to 17	@RWi + disp8	1
18 to 1B	@RWj + disp16	1
1C 1D 1E 1F	@RW0 + RW7 @RW1 + RW7 @PC + dip16 @addr16	2 2 2 1

* : “(a)” is used in the “cycles” (number of cycles) column and column B (correction value) in the Table of Instructions.

Table 5 Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles

Operand	(b)*		(c)*		(d)*	
	byte		word		long	
Internal register	+	0	+	0	+	0
Internal RAM even address	+	0	+	0	+	0
Internal RAM odd address	+	0	+	1	+	2
Even address not in internal RAM	+	1	+	1	+	2
Odd address not in internal RAM	+	1	+	3	+	6
External data bus (8 bits)	+	1	+	3	+	6

* : “(b)”, “(c)”, and “(d)” are used in the “cycles” (number of cycles) column and column B (correction value) in the Table of Instructions.

Table 6 Transfer Instructions (Byte) [50 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
MOV A, dir	2	2	(b)	byte (A) ← (dir)	Z	*	–	–	–	*	*	–	–	–
MOV A, addr16	3	2	(b)	byte (A) ← (addr16)	Z	*	–	–	–	*	*	–	–	–
MOV A, Ri	1	1	0	byte (A) ← (Ri)	Z	*	–	–	–	*	*	–	–	–
MOV A, ear	2	1	0	byte (A) ← (ear)	Z	*	–	–	–	*	*	–	–	–
MOV A, eam	2+	2+ (a)	(b)	byte (A) ← (eam)	Z	*	–	–	–	*	*	–	–	–
MOV A, io	2	2	(b)	byte (A) ← (io)	Z	*	–	–	–	*	*	–	–	–
MOV A, #imm8	2	2	0	byte (A) ← imm8	Z	*	–	–	–	*	*	–	–	–
MOV A, @A	2	2	(b)	byte (A) ← ((A))	Z	–	–	–	–	*	*	–	–	–
MOV A, @RLi+disp8	3	6	(b)	byte (A) ← ((RLi))+disp8)	Z	*	–	–	–	*	*	–	–	–
MOV A, @SP+disp8	3	3	(b)	byte (A) ← ((SP)+disp8)	Z	*	–	–	–	*	*	–	–	–
MOVP A, addr24	5	3	(b)	byte (A) ←(addr24)	Z	*	–	–	–	*	*	–	–	–
MOVP A, @A	2	2	(b)	byte (A) ← ((A))	Z	–	–	–	–	*	*	–	–	–
MOVN A, #imm4	1	1	0	byte (A) ← imm4	Z	*	–	–	–	R	*	–	–	–
MOVX A, dir	2	2	(b)	byte (A) ← (dir)	X	*	–	–	–	*	*	–	–	–
MOVX A, addr16	3	2	(b)	byte (A) ← (addr16)	X	*	–	–	–	*	*	–	–	–
MOVX A, Ri	2	1	0	byte (A) ← (Ri)	X	*	–	–	–	*	*	–	–	–
MOVX A, ear	2	1	0	byte (A) ← (ear)	X	*	–	–	–	*	*	–	–	–
MOVX A, eam	2+	2+ (a)	(b)	byte (A) ← (eam)	X	*	–	–	–	*	*	–	–	–
MOVX A, io	2	2	(b)	byte (A) ← (io)	X	*	–	–	–	*	*	–	–	–
MOVX A, #imm8	2	2	0	byte (A) ← imm8	X	*	–	–	–	*	*	–	–	–
MOVX A, @A	2	2	(b)	byte (A) ← ((A))	X	–	–	–	–	*	*	–	–	–
MOVX A,@RWi+disp8	2	3	(b)	byte (A) ← ((RWi))+disp8)	X	*	–	–	–	*	*	–	–	–
MOVX A, @RLi+disp8	3	6	(b)	byte (A) ← ((RLi))+disp8)	X	*	–	–	–	*	*	–	–	–
MOVX A, @SP+disp8	3	3	(b)	byte (A) ← ((SP)+disp8)	X	*	–	–	–	*	*	–	–	–
MOVPX A, addr24	5	3	(b)	byte (A) ←(addr24)	X	*	–	–	–	*	*	–	–	–
MOVPX A, @A	2	2	(b)	byte (A) ← ((A))	X	–	–	–	–	*	*	–	–	–
MOV dir, A	2	2	(b)	byte (dir) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV addr16, A	3	2	(b)	byte (addr16) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV Ri, A	1	1	0	byte (Ri) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV ear, A	2	2	0	byte (ear) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV eam, A	2+	2+ (a)	(b)	byte (eam) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV io, A	2	2	(b)	byte (io) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV @RLi+disp8, A	3	6	(b)	byte ((RLi)) +disp8) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV @SP+disp8, A	3	3	(b)	byte ((SP)+disp8) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVP addr24, A	5	3	(b)	byte (addr24) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV Ri, ear	2	2	0	byte (Ri) ← (ear)	–	–	–	–	–	*	*	–	–	–
MOV Ri, eam	2+	3+ (a)	(b)	byte (Ri) ← (eam)	–	–	–	–	–	*	*	–	–	–
MOVP @A, Ri	2	3	(b)	byte ((A)) ← (Ri)	–	–	–	–	–	*	*	–	–	–
MOV ear, Ri	2	3	0	byte (ear) ← (Ri)	–	–	–	–	–	*	*	–	–	–
MOV eam, Ri	2+	3+ (a)	(b)	byte (eam) ← (Ri)	–	–	–	–	–	*	*	–	–	–
MOV Ri, #imm8	2	2	0	byte (Ri) ← imm8	–	–	–	–	–	*	*	–	–	–
MOV io, #imm8	3	3	(b)	byte (io) ← imm8	–	–	–	–	–	–	–	–	–	–
MOV dir, #imm8	3	3	(b)	byte (dir) ← imm8	–	–	–	–	–	–	–	–	–	–
MOV ear, #imm8	3	2	0	byte (ear) ← imm8	–	–	–	–	–	*	*	–	–	–
MOV eam, #imm8	3+	2+ (a)	(b)	byte (eam) ← imm8	–	–	–	–	–	–	–	–	–	–
MOV @AL, AH	2	2	(b)	byte ((A)) ← (AH)	–	–	–	–	–	*	*	–	–	–

(Continued)

(Continued)

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
XCH A, ear	2	3	0	byte (A) ↔ (ear)	Z	–	–	–	–	–	–	–	–	–
XCH A, eam	2+	3+ (a)	2× (b)	byte (A) ↔ (eam)	Z	–	–	–	–	–	–	–	–	–
XCH Ri, ear	2	4	0	byte (Ri) ↔ (ear)	–	–	–	–	–	–	–	–	–	–
XCH Ri, eam	2+	5+ (a)	2× (b)	byte (Ri) ↔ (eam)	–	–	–	–	–	–	–	–	–	–

For an explanation of “(a)” and “(b)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 7 Transfer Instructions (Word) [40 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
MOVW A, dir	2	2	(c)	word (A) ← (dir)	–	*	–	–	–	*	*	–	–	–
MOVW A, addr16	3	2	(c)	word (A) ← (addr16)	–	*	–	–	–	*	*	–	–	–
MOVW A, SP	1	2	0	word (A) ← (SP)	–	*	–	–	–	*	*	–	–	–
MOVW A, RWi	1	1	0	word (A) ← (RWi)	–	*	–	–	–	*	*	–	–	–
MOVW A, ear	2	1	0	word (A) ← (ear)	–	*	–	–	–	*	*	–	–	–
MOVW A, eam	2+	2+ (a)	(c)	word (A) ← (eam)	–	*	–	–	–	*	*	–	–	–
MOVW A, io	2	2	(c)	word (A) ← (io)	–	*	–	–	–	*	*	–	–	–
MOVW A, @A	2	2	(c)	word (A) ← ((A))	–	–	–	–	–	*	*	–	–	–
MOVW A, #imm16	3	2	0	word (A) ← imm16	–	*	–	–	–	*	*	–	–	–
MOVW A, @RWi+disp8	2	3	(c)	word (A) ← ((RWi) +disp8)	–	*	–	–	–	*	*	–	–	–
MOVW A, @RLi+disp8	3	6	(c)	word (A) ← ((RLi) +disp8)	–	*	–	–	–	*	*	–	–	–
MOVW A, @SP+disp8	3	3	(c)	word (A) ← ((SP) +disp8	–	*	–	–	–	*	*	–	–	–
MOVPW A, addr24	5	3	(c)	word (A) ← (addr24)	–	*	–	–	–	*	*	–	–	–
MOVPW A, @A	2	2	(c)	word (A) ← ((A))	–	–	–	–	–	*	*	–	–	–
MOVW dir, A	2	2	(c)	word (dir) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW addr16, A	3	2	(c)	word (addr16) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW SP, # imm16	4	2	0	word (SP) ← imm16	–	–	–	–	–	*	*	–	–	–
MOVW SP, A	1	2	0	word (SP) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW RWi, A	1	1	0	word (RWi) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW ear, A	2	2	0	word (ear) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW eam, A	2+	2+ (a)	(c)	word (eam) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW io, A	2	2	(c)	word (io) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW @RWi+disp8, A	2	3	(c)	word ((RWi) +disp8) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW @RLi+disp8, A	3	6	(c)	word ((RLi) +disp8) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVW @SP+disp8, A	3	3	(c)	word ((SP) +disp8) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVPW addr24, A	5	3	(c)	word (addr24) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVPW @A, RWi	2	3	(c)	word ((A)) ← (RWi)	–	–	–	–	–	*	*	–	–	–
MOVW RWi, ear	2	2	0	word (RWi) ← (ear)	–	–	–	–	–	*	*	–	–	–
MOVW RWi, eam	2+	3+ (a)	(c)	word (RWi) ← (eam)	–	–	–	–	–	*	*	–	–	–
MOVW ear, RWi	2	3	0	word (ear) ← (RWi)	–	–	–	–	–	*	*	–	–	–
MOVW eam, RWi	2+	3+ (a)	(c)	word (eam) ← (RWi)	–	–	–	–	–	*	*	–	–	–
MOVW RWi, #imm16	3	2	0	word (RWi) ← imm16	–	–	–	–	–	*	*	–	–	–
MOVW io, #imm16	4	3	(c)	word (io) ← imm16	–	–	–	–	–	–	–	–	–	–
MOVW ear, #imm16	4	2	0	word (ear) ← imm16	–	–	–	–	–	*	*	–	–	–
MOVW eam, #imm16	4+	2+ (a)	(c)	word (eam) ← imm16	–	–	–	–	–	–	–	–	–	–
MOVW @AL, AH	2	2	(c)	word ((A)) ← (AH)	–	–	–	–	–	*	*	–	–	–
XCHW A, ear	2	3	0	word (A) ↔ (ear)	–	–	–	–	–	–	–	–	–	–
XCHW A, eam	2+	3+ (a)	2× (c)	word (A) ↔ (eam)	–	–	–	–	–	–	–	–	–	–
XCHW RWi, ear	2	4	0	word (RWi) ↔ (ear)	–	–	–	–	–	–	–	–	–	–
XCHW RWi, eam	2+	5+ (a)	2× (c)	word (RWi) ↔ (eam)	–	–	–	–	–	–	–	–	–	–

Note: For an explanation of “(a)” and “(c)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 8 Transfer Instructions (Long Word) [11 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
MOVL A, ear	2	1	0	long (A) ← (ear)	–	–	–	–	–	*	*	–	–	–
MOVL A, eam	2+	3+ (a)	(d)	long (A) ← (eam)	–	–	–	–	–	*	*	–	–	–
MOVL A, # imm32	5	3	0	long (A) ← imm32	–	–	–	–	–	*	*	–	–	–
MOVL A, @SP + disp8	3	4	(d)	long (A) ← ((SP) +disp8)	–	–	–	–	–	*	*	–	–	–
MOVPL A, addr24	5	4	(d)	long (A) ← (addr24)	–	–	–	–	–	*	*	–	–	–
MOVPL A, @A	2	3	(d)	long (A) ← ((A))	–	–	–	–	–	*	*	–	–	–
MOVPL @A, RLi	2	5	(d)	long ((A)) ← (RLi)	–	–	–	–	–	*	*	–	–	–
MOVL @SP + disp8, A	3	4	(d)	long ((SP) + disp8) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVPL addr24, A	5	4	(d)	long (addr24) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVL ear, A	2	2	0	long (ear) ← (A)	–	–	–	–	–	*	*	–	–	–
MOVL eam, A	2+	3+ (a)	(d)	long (eam) ← (A)	–	–	–	–	–	*	*	–	–	–

For an explanation of “(a)” and “(d)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 9 Addition and Subtraction Instructions (Byte/Word/Long Word) [42 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
ADD A, #imm8	2	2	0	byte (A) ← (A) +imm8	Z	–	–	–	–	*	*	*	*	–
ADD A, dir	2	3	(b)	byte (A) ← (A) +(dir)	Z	–	–	–	–	*	*	*	*	–
ADD A, ear	2	2	0	byte (A) ← (A) +(ear)	Z	–	–	–	–	*	*	*	*	–
ADD A, eam	2+	3+ (a)	(b)	byte (A) ← (A) +(eam)	Z	–	–	–	–	*	*	*	*	–
ADD ear, A	2	2	0	byte (ear) ← (ear) + (A)	–	–	–	–	–	*	*	*	*	*
ADD eam, A	2+	3+ (a)	2× (b)	byte (eam) ← (eam) + (A)	Z	–	–	–	–	*	*	*	*	*
ADDC A	1	2	0	byte (A) ← (AH) + (AL) + (C)	Z	–	–	–	–	*	*	*	*	–
ADDC A, ear	2	2	0	byte (A) ← (A) + (ear) + (C)	Z	–	–	–	–	*	*	*	*	–
ADDC A, eam	2+	3+ (a)	(b)	byte (A) ← (A) + (eam) + (C)	Z	–	–	–	–	*	*	*	*	–
ADDDC A	1	3	0	byte (A) ← (AH) + (AL) + (C) (Decimal)	Z	–	–	–	–	*	*	*	*	–
SUB A, #imm8	2	2	0	byte (A) ← (A) –imm8	Z	–	–	–	–	*	*	*	*	–
SUB A, dir	2	3	(b)	byte (A) ← (A) – (dir)	Z	–	–	–	–	*	*	*	*	–
SUB A, ear	2	2	0	byte (A) ← (A) – (ear)	Z	–	–	–	–	*	*	*	*	–
SUB A, eam	2+	3+ (a)	(b)	byte (A) ← (A) – (eam)	Z	–	–	–	–	*	*	*	*	–
SUB ear, A	2	2	0	byte (ear) ← (ear) – (A)	–	–	–	–	–	*	*	*	*	*
SUB eam, A	2+	3+ (a)	2× (b)	byte (eam) ← (eam) – (A)	–	–	–	–	–	*	*	*	*	*
SUBC A	1	2	0	byte (A) ← (AH) – (AL) – (C)	Z	–	–	–	–	*	*	*	*	–
SUBC A, ear	2	2	0	byte (A) ← (A) – (ear) – (C)	Z	–	–	–	–	*	*	*	*	–
SUBC A, eam	2+	3+ (a)	(b)	byte (A) ← (A) – (eam) – (C)	Z	–	–	–	–	*	*	*	*	–
SUBDC A	1	3	0	byte (A) ← (AH) – (AL) – (C) (Decimal)	Z	–	–	–	–	*	*	*	*	–
ADDW A	1	2	0	word (A) ← (AH) + (AL)	–	–	–	–	–	*	*	*	*	–
ADDW A, ear	2	2	0	word (A) ← (A) +(ear)	–	–	–	–	–	*	*	*	*	–
ADDW A, eam	2+	3+ (a)	(c)	word (A) ← (A) +(eam)	–	–	–	–	–	*	*	*	*	–
ADDW A, #imm16	3	2	0	word (A) ← (A) +imm16	–	–	–	–	–	*	*	*	*	–
ADDW ear, A	2	2	0	word (ear) ← (ear) + (A)	–	–	–	–	–	*	*	*	*	*
ADDW eam, A	2+	3+ (a)	2× (c)	word (eam) ← (eam) + (A)	–	–	–	–	–	*	*	*	*	*
ADDCW A, ear	2	2	0	word (A) ← (A) + (ear) + (C)	–	–	–	–	–	*	*	*	*	–
ADDCW A, eam	2+	3+ (a)	(c)	word (A) ← (A) + (eam) + (C)	–	–	–	–	–	*	*	*	*	–
SUBW A	1	2	0	word (A) ← (AH) – (AL)	–	–	–	–	–	*	*	*	*	–
SUBW A, ear	2	2	0	word (A) ← (A) – (ear)	–	–	–	–	–	*	*	*	*	–
SUBW A, eam	2+	3+ (a)	(c)	word (A) ← (A) – (eam)	–	–	–	–	–	*	*	*	*	–
SUBW A, #imm16	3	2	0	word (A) ← (A) –imm16	–	–	–	–	–	*	*	*	*	–
SUBW ear, A	2	2	0	word (ear) ← (ear) – (A)	–	–	–	–	–	*	*	*	*	*
SUBW eam, A	2+	3+ (a)	2× (c)	word (eam) ← (eam) – (A)	–	–	–	–	–	*	*	*	*	*
SUBCW A, ear	2	2	0	word (A) ← (A) – (ear) – (C)	–	–	–	–	–	*	*	*	*	–
SUBCW A, eam	2+	3+ (a)	(c)	word (A) ← (A) – (eam) – (C)	–	–	–	–	–	*	*	*	*	–
ADDL A, ear	2	5	0	long (A) ← (A) + (ear)	–	–	–	–	–	*	*	*	*	–
ADDL A, eam	2+	6+ (a)	(d)	long (A) ← (A) + (eam)	–	–	–	–	–	*	*	*	*	–
ADDL A, #imm32	5	4	0	long (A) ← (A) +imm32	–	–	–	–	–	*	*	*	*	–
SUBL A, ear	2	5	0	long (A) ← (A) – (ear)	–	–	–	–	–	*	*	*	*	–
SUBL A, eam	2+	6+ (a)	(d)	long (A) ← (A) – (eam)	–	–	–	–	–	*	*	*	*	–
SUBL A, #imm32	5	4	0	long (A) ← (A) –imm32	–	–	–	–	–	*	*	*	*	–

For an explanation of “(a)”, “(b)”, “(c)” and “(d)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 10 Increment and Decrement Instructions (Byte/Word/Long Word) [12 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
INC ear	2	2	0	byte (ear) ← (ear) +1	–	–	–	–	–	*	*	*	–	*
INC eam	2+	3+ (a)	2× (b)	byte (eam) ← (eam) +1	–	–	–	–	–	*	*	*	–	*
DEC ear	2	2	0	byte (ear) ← (ear) –1	–	–	–	–	–	*	*	*	–	*
DEC eam	2+	3+ (a)	2× (b)	byte (eam) ← (eam) –1	–	–	–	–	–	*	*	*	–	*
INCW ear	2	2	0	word (ear) ← (ear) +1	–	–	–	–	–	*	*	*	–	*
INCW eam	2+	3+ (a)	2× (c)	word (eam) ← (eam) +1	–	–	–	–	–	*	*	*	–	*
DECW ear	2	2	0	word (ear) ← (ear) –1	–	–	–	–	–	*	*	*	–	*
DECW eam	2+	3+ (a)	2× (c)	word (eam) ← (eam) –1	–	–	–	–	–	*	*	*	–	*
INCL ear	2	4	0	long (ear) ← (ear) +1	–	–	–	–	–	*	*	*	–	*
INCL eam	2+	5+ (a)	2× (d)	long (eam) ← (eam) +1	–	–	–	–	–	*	*	*	–	*
DECL ear	2	4	0	long (ear) ← (ear) –1	–	–	–	–	–	*	*	*	–	*
DECL eam	2+	5+ (a)	2× (d)	long (eam) ← (eam) –1	–	–	–	–	–	*	*	*	–	*

For an explanation of “(a)”, “(b)”, “(c)” and “(d)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 11 Compare Instructions (Byte/Word/Long Word) [11 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
CMP A	1	2	0	byte (AH) – (AL)	–	–	–	–	–	*	*	*	*	–
CMP A, ear	2	2	0	byte (A) – (ear)	–	–	–	–	–	*	*	*	*	–
CMP A, eam	2+	2+ (a)	(b)	byte (A) – (eam)	–	–	–	–	–	*	*	*	*	–
CMP A, #imm8	2	2	0	byte (A) – imm8	–	–	–	–	–	*	*	*	*	–
CMPW A	1	2	0	word (AH) – (AL)	–	–	–	–	–	*	*	*	*	–
CMPW A, ear	2	2	0	word (A) – (ear)	–	–	–	–	–	*	*	*	*	–
CMPW A, eam	2+	2+ (a)	(c)	word (A) – (eam)	–	–	–	–	–	*	*	*	*	–
CMPW A, #imm16	3	2	0	word (A) – imm16	–	–	–	–	–	*	*	*	*	–
CMPL A, ear	2	3	0	long (A) – (ear)	–	–	–	–	–	*	*	*	*	–
CMPL A, eam	2+	4+ (a)	(d)	long (A) – (eam)	–	–	–	–	–	*	*	*	*	–
CMPL A, #imm32	5	3	0	long (A) – imm32	–	–	–	–	–	*	*	*	*	–

For an explanation of “(a)”, “(b)”, “(c)” and “(d)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 12 Unsigned Multiplication and Division Instructions (Word/Long Word) [11 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
DIVU A	1	*1	0	word (AH) /byte (AL) Quotient → byte (AL) Remainder → byte (AH)	–	–	–	–	–	–	–	*	*	–
DIVU A, ear	2	*2	0	word (A)/byte (ear) Quotient → byte (A) Remainder → byte (ear)	–	–	–	–	–	–	–	*	*	–
DIVU A, eam	2+	*3	*6	word (A)/byte (eam) Quotient → byte (A) Remainder → byte (eam)	–	–	–	–	–	–	–	*	*	–
DIVUW A, ear	2	*4	0	long (A)/word (ear) Quotient → word (A) Remainder → word (ear)	–	–	–	–	–	–	–	*	*	–
DIVUW A, eam	2+	*5	*7	long (A)/word (eam) Quotient → word (A) Remainder → word (eam)	–	–	–	–	–	–	–	*	*	–
MULU A	1	*8	0	byte (AH) × byte (AL) → word (A)	–	–	–	–	–	–	–	–	–	–
MULU A, ear	2	*9	0	byte (A) × byte (ear) → word (A)	–	–	–	–	–	–	–	–	–	–
MULU A, eam	2+	*10	(b)	byte (A) × byte (eam) → word (A)	–	–	–	–	–	–	–	–	–	–
MULUW A	1	*11	0	word (AH) × word (AL) → long (A)	–	–	–	–	–	–	–	–	–	–
MULUW A, ear	2	*12	0	word (A) × word (ear) → long (A)	–	–	–	–	–	–	–	–	–	–
MULUW A, eam	2+	*13	(c)	word (A) × word (eam) → long (A)	–	–	–	–	–	–	–	–	–	–

For an explanation of “(b)” and “(c), refer to Table 5, “Correction Values for Number of Cycle Used to Calculate Number of Actual Cycles.”

*1: 3 when dividing into zero, 6 when an overflow occurs, and 14 normally.
*2: 3 when dividing into zero, 5 when an overflow occurs, and 13 normally.
*3: 5 + (a) when dividing into zero, 7 + (a) when an overflow occurs, and 17 + (a) normally.
*4: 3 when dividing into zero, 5 when an overflow occurs, and 21 normally.
*5: 4 + (a) when dividing into zero, 7 + (a) when an overflow occurs, and 25 + (a) normally.
*6: (b) when dividing into zero or when an overflow occurs, and 2 × (b) normally.
*7: (c) when dividing into zero or when an overflow occurs, and 2 × (c) normally.
*8: 3 when byte (AH) is zero, and 7 when byte (AH) is not 0.
*9: 3 when byte (ear) is zero, and 7 when byte (ear) is not 0.
*10: 4 + (a) when byte (eam) is zero, and 8 + (a) when byte (eam) is not 0.
*11: 3 when word (AH) is zero, and 11 when word (AH) is not 0.
*12: 3 when word (ear) is zero, and 11 when word (ear) is not 0.
*13: 4 + (a) when word (eam) is zero, and 12 + (a) when word (eam) is not 0.

Table 13 Signed Multiplication and Division Instructions (Word/Long Word) [11 Insturctions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
DIV A	2	*1	0	word (AH) /byte (AL) Quotient → byte (AL) Remainder → byte (AH)	Z	–	–	–	–	–	–	*	*	–
DIV A, ear	2	*2	0	word (A)/byte (ear) Quotient → byte (A) Remainder → byte (ear)	Z	–	–	–	–	–	–	*	*	–
DIV A, eam	2+	*3	*6	word (A)/byte (eam) Quotient → byte (A) Remainder → byte (eam)	Z	–	–	–	–	–	–	*	*	–
DIVW A, ear	2	*4	0	long (A)/word (ear) Quotient → word (A) Remainder → word (ear)	–	–	–	–	–	–	–	*	*	–
DIVW A, eam	2+	*5	*7	long (A)/word (eam) Quotient → word (A) Remainder → word (eam)	–	–	–	–	–	–	–	*	*	–
MUL A	2	*8	0	byte (AH) × byte (AL) → word (A)	–	–	–	–	–	–	–	–	–	–
MUL A, ear	2	*9	0	byte (A) × byte (ear) → word (A)	–	–	–	–	–	–	–	–	–	–
MUL A, eam	2+	*10	(b)	byte (A) × byte (eam) → word (A)	–	–	–	–	–	–	–	–	–	–
MULW A	2	*11	0	word (AH) × word (AL) → long (A)	–	–	–	–	–	–	–	–	–	–
MULW A, ear	2	*12	0	word (A) × word (ear) → long (A)	–	–	–	–	–	–	–	–	–	–
MULW A, eam	2+	*13	(b)	word (A) × word (eam) → long (A)	–	–	–	–	–	–	–	–	–	–

For an explanation of “(b)” and “(c)”, refer to Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

*1: 3 when dividing into zero, 8 or 18 when an overflow occurs, and 18 normally.
*2: 3 when dividing into zero, 10 or 21 when an overflow occurs, and 22 normally.
*3: 4 + (a) when dividing into zero, 11 + (a) or 22 + (a) when an overflow occurs, and 23 + (a) normally.
*4: When the dividend is positive: 4 when dividing into zero, 10 or 29 when an overflow occurs, and 30 normally.
When the dividend is negative: 4 when dividing into zero, 11 or 30 when an overflow occurs, and 31 normally.
*5: When the dividend is positive: 4 + (a) when dividing into zero, 11 + (a) or 30 + (a) when an overflow occurs, and 31 + (a) normally.
When the dividend is negative: 4 + (a) when dividing into zero, 12 + (a) or 31 + (a) when an overflow occurs, and 32 + (a) normally.
*6: (b) when dividing into zero or when an overflow occurs, and 2 × (b) normally.
*7: (c) when dividing into zero or when an overflow occurs, and 2 × (c) normally.
*8: 3 when byte (AH) is zero, 12 when the result is positive, and 13 when the result is negative.
*9: 3 when byte (ear) is zero, 12 when the result is positive, and 13 when the result is negative.
*10: 4 + (a) when byte (eam) is zero, 13 + (a) when the result is positive, and 14 + (a) when the result is negative.
*11: 3 when word (AH) is zero, 12 when the result is positive, and 13 when the result is negative.
*12: 3 when word (ear) is zero, 16 when the result is positive, and 19 when the result is negative.
*13: 4 + (a) when word (eam) is zero, 17 + (a) when the result is positive, and 20 + (a) when the result is negative.
Note: Which of the two values given for the number of execution cycles applies when an overflow error occurs in a DIV or DIVW instruction depends on whether the overflow was detected before or after the operation.

Table 14 Logical 1 Instructions (Byte, Word) [39 Instructions]

Mnemonic		#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
AND	A, #imm8	2	2	0	byte (A) ← (A) and imm8	–	–	–	–	–	*	*	R	–	–
AND	A, ear	2	2	0	byte (A) ← (A) and (ear)	–	–	–	–	–	*	*	R	–	–
AND	A, eam	2+	3+ (a)	(b)	byte (A) ← (A) and (eam)	–	–	–	–	–	*	*	R	–	–
AND	ear, A	2	3	0	byte (ear) ← (ear) and (A)	–	–	–	–	–	*	*	R	–	*
AND	eam, A	2+	3+ (a)	2× (b)	byte (eam) ← (eam) and (A)	–	–	–	–	–	*	*	R	–	*
OR	A, #imm8	2	2	0	byte (A) ← (A) or imm8	–	–	–	–	–	*	*	R	–	–
OR	A, ear	2	2	0	byte (A) ← (A) or (ear)	–	–	–	–	–	*	*	R	–	–
OR	A, eam	2+	3+ (a)	(b)	byte (A) ← (A) or (eam)	–	–	–	–	–	*	*	R	–	–
OR	ear, A	2	3	0	byte (ear) ← (ear) or (A)	–	–	–	–	–	*	*	R	–	*
OR	eam, A	2+	3+ (a)	2× (b)	byte (eam) ← (eam) or (A)	–	–	–	–	–	*	*	R	–	*
XOR	A, #imm8	2	2	0	byte (A) ← (A) xor imm8	–	–	–	–	–	*	*	R	–	–
XOR	A, ear	2	2	0	byte (A) ← (A) xor (ear)	–	–	–	–	–	*	*	R	–	–
XOR	A, eam	2+	3+ (a)	(b)	byte (A) ← (A) xor (eam)	–	–	–	–	–	*	*	R	–	–
XOR	ear, A	2	3	0	byte (ear) ← (ear) xor (A)	–	–	–	–	–	*	*	R	–	*
XOR	eam, A	2+	3+ (a)	2× (b)	byte (eam) ← (eam) xor (A)	–	–	–	–	–	*	*	R	–	*
NOT	A	1	2	0	byte (A) ← not (A)	–	–	–	–	–	*	*	R	–	–
NOT	ear	2	2	0	byte (ear) ← not (ear)	–	–	–	–	–	*	*	R	–	*
NOT	eam	2+	3+ (a)	2× (b)	byte (eam) ← not (eam)	–	–	–	–	–	*	*	R	–	*
ANDW	A	1	2	0	word (A) ← (AH) and (A)	–	–	–	–	–	*	*	R	–	–
ANDW	A, #imm16	3	2	0	word (A) ← (A) and imm16	–	–	–	–	–	*	*	R	–	–
ANDW	A, ear	2	2	0	word (A) ← (A) and (ear)	–	–	–	–	–	*	*	R	–	–
ANDW	A, eam	2+	3+ (a)	(c)	word (A) ← (A) and (eam)	–	–	–	–	–	*	*	R	–	–
ANDW	ear, A	2	3	0	word (ear) ← (ear) and (A)	–	–	–	–	–	*	*	R	–	*
ANDW	eam, A	2+	3+ (a)	2× (c)	word (eam) ← (eam) and (A)	–	–	–	–	–	*	*	R	–	*
ORW	A	1	2	0	word (A) ← (AH) or (A)	–	–	–	–	–	*	*	R	–	–
ORW	A, #imm16	3	2	0	word (A) ← (A) or imm16	–	–	–	–	–	*	*	R	–	–
ORW	A, ear	2	2	0	word (A) ← (A) or (ear)	–	–	–	–	–	*	*	R	–	–
ORW	A, eam	2+	3+ (a)	(c)	word (A) ← (A) or (eam)	–	–	–	–	–	*	*	R	–	–
ORW	ear, A	2	3	0	word (ear) ← (ear) or (A)	–	–	–	–	–	*	*	R	–	*
ORW	eam, A	2+	3+ (a)	2× (c)	word (eam) ← (eam) or (A)	–	–	–	–	–	*	*	R	–	*
XORW	A	1	2	0	word (A) ← (AH) xor (A)	–	–	–	–	–	*	*	R	–	–
XORW	A, #imm16	3	2	0	word (A) ← (A) xor imm16	–	–	–	–	–	*	*	R	–	–
XORW	A, ear	2	2	0	word (A) ← (A) xor (ear)	–	–	–	–	–	*	*	R	–	–
XORW	A, eam	2+	3+ (a)	(c)	word (A) ← (A) xor (eam)	–	–	–	–	–	*	*	R	–	–
XORW	ear, A	2	3	0	word (ear) ← (ear) xor (A)	–	–	–	–	–	*	*	R	–	*
XORW	eam, A	2+	3+ (a)	2× (c)	word (eam) ← (eam) xor (A)	–	–	–	–	–	*	*	R	–	*
NOTW	A	1	2	0	word (A) ← not (A)	–	–	–	–	–	*	*	R	–	–
NOTW	ear	2	2	0	word (ear) ← not (ear)	–	–	–	–	–	*	*	R	–	*
NOTW	eam	2+	3+ (a)	2× (c)	word (eam) ← not (eam)	–	–	–	–	–	*	*	R	–	*

For an explanation of “(a)”, “(b)”, “(c)” and “(d)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 15 Logical 2 Instructions (Long Word) [6 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
ANDL A, ear	2	5	0	long (A) ← (A) and (ear)	–	–	–	–	–	*	*	R	–	–
ANDL A, eam	2+	6+ (a)	(d)	long (A) ← (A) and (eam)	–	–	–	–	–	*	*	R	–	–
ORL A, ear	2	5	0	long (A) ← (A) or (ear)	–	–	–	–	–	*	*	R	–	–
ORL A, eam	2+	6+ (a)	(d)	long (A) ← (A) or (eam)	–	–	–	–	–	*	*	R	–	–
XORL A, ear	2	5	0	long (A) ← (A) xor (ear)	–	–	–	–	–	*	*	R	–	–
XORL A, eam	2+	6+ (a)	(d)	long (A) ← (A) xor (eam)	–	–	–	–	–	*	*	R	–	–

For an explanation of “(a)” and “(d)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 16 Sign Inversion Instructions (Byte/Word) [6 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
NEG A	1	2	0	byte (A) ← 0 – (A)	X	–	–	–	–	*	*	*	*	–
NEG ear	2	2	0	byte (ear) ← 0 – (ear)	–	–	–	–	–	*	*	*	*	*
NEG eam	2+	3+ (a)	2× (b)	byte (eam) ← 0 – (eam)	–	–	–	–	–	*	*	*	*	*
NEGW A	1	2	0	word (A) ← 0 – (A)	–	–	–	–	–	*	*	*	*	–
NEGW ear	2	2	0	word (ear) ← 0 – (ear)	–	–	–	–	–	*	*	*	*	*
NEGW eam	2+	3+ (a)	2× (c)	word (eam) ← 0 – (eam)	–	–	–	–	–	*	*	*	*	*

For an explanation of “(a)”, “(b)” and “(c)” and refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

Table 17 Absolute Value Instructions (Byte/Word/Long Word) [3 Insturctions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
ABS A	2	2	0	byte (A) ← absolute value (A)	Z	–	–	–	–	*	*	*	–	–
ABSW A	2	2	0	word (A) ← absolute value (A)	–	–	–	–	–	*	*	*	–	–
ABSL A	2	4	0	long (A) ← absolute value (A)	–	–	–	–	–	*	*	*	–	–

Table 18 Normalize Instructions (Long Word) [1 Instruction]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
NRML A, R0	2	*	0	long (A) ← Shifts to the position at which “1” was set first byte (R0) ← current shift count	–	–	–	–	*	–	–	–	–	–

* : 5 when the contents of the accumulator are all zeroes, 5 + (R0) in all other cases.

Table 19 Shift Instructions (Byte/Word/Long Word) [27 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
RORC A	2	2	0	byte (A) ← Right rotation with carry	–	–	–	–	–	*	*	–	*	–
ROLC A	2	2	0	byte (A) ← Left rotation with carry	–	–	–	–	–	*	*	–	*	–
RORC ear	2	2	0	byte (ear) ← Right rotation with carry	–	–	–	–	–	*	*	–	*	*
RORC eam	2+	3+ (a)	2× (b)	byte (eam) ← Right rotation with carry	–	–	–	–	–	*	*	–	*	*
ROLC ear	2	2	0	byte (ear) ← Left rotation with carry	–	–	–	–	–	*	*	–	*	*
ROLC eam	2+	3+ (a)	2× (b)	byte (eam) ← Left rotation with carry	–	–	–	–	–	*	*	–	*	*
ASR A, R0	2	*1	0	byte (A) ← Arithmetic right barrel shift (A, R0)	–	–	–	–	*	*	*	–	*	–
LSR A, R0	2	*1	0	byte (A) ← Logical right barrel shift (A, R0)	–	–	–	–	*	*	*	–	*	–
LSL A, R0	2	*1	0	byte (A) ← Logical left barrel shift (A, R0)	–	–	–	–	–	*	*	–	*	–
ASR A, #imm8	3	*3	0	byte (A) ← Arithmetic right barrel shift (A, imm8)	–	–	–	–	*	*	*	–	*	–
LSR A, #imm8	3	*3	0	byte (A) ← Logical right barrel shift (A, imm8)	–	–	–	–	*	*	*	–	*	–
LSL A, #imm8	3	*3	0	byte (A) ← Logical left barrel shift (A, imm8)	–	–	–	–	–	*	*	–	*	–
ASRW A	1	2	0	word (A) ← Arithmetic right shift (A, 1 bit)	–	–	–	–	*	*	*	–	*	–
LSRW A/SHRW A	1	2	0	word (A) ← Logical right shift (A, 1 bit)	–	–	–	–	*	R	*	–	*	–
LSLW A/SHLW A	1	2	0	word (A) ← Logical left shift (A, 1 bit)	–	–	–	–	–	*	*	–	*	–
ASRW A, R0	2	*1	0	word (A) ← Arithmetic right barrel shift (A, R0)	–	–	–	–	*	*	*	–	*	–
LSRW A, R0	2	*1	0	word (A) ← Logical right barrel shift (A, R0)	–	–	–	–	*	*	*	–	*	–
LSLW A, R0	2	*1	0	word (A) ← Logical left barrel shift (A, R0)	–	–	–	–	–	*	*	–	*	–
ASRW A, #imm8	3	*3	0	word (A) ← Arithmetic right barrel shift (A, imm8)	–	–	–	–	*	*	*	–	*	–
LSRW A, #imm8	3	*3	0	word (A) ← Logical right barrel shift (A, imm8)	–	–	–	–	*	*	*	–	*	–
LSLW A, #imm8	3	*3	0	word (A) ← Logical left barrel shift (A, imm8)	–	–	–	–	–	*	*	–	*	–
ASRL A, R0	2	*2	0	long (A) ← Arithmetic right shift (A, R0)	–	–	–	–	*	*	*	–	*	–
LSRL A, R0	2	*2	0	long (A) ← Logical right barrel shift (A, R0)	–	–	–	–	*	*	*	–	*	–
LSLL A, R0	2	*2	0	long (A) ← Logical left barrel shift (A, R0)	–	–	–	–	–	*	*	–	*	–
ASRL A, #imm8	3	*4	0	long (A) ← Arithmetic right shift (A, imm8)	–	–	–	–	*	*	*	–	*	–
LSRL A, #imm8	3	*4	0	long (A) ← Logical right barrel shift (A, imm8)	–	–	–	–	*	*	*	–	*	–
LSLL A, #imm8	3	*4	0	long (A) ← Logical left barrel shift (A, imm8)	–	–	–	–	–	*	*	–	*	–

For an explanation of “(a)” and “(b)”, refer to Table 4, “Number of Execution Cycles for Each Form of Addressing,” and Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

*1: 3 when R0 is 0, 3 + (R0) in all other cases.

*2: 3 when R0 is 0, 4 + (R0) in all other cases.

*3: 3 when imm8 is 0, 3 + (imm8) in all other cases.

*4: 3 when imm8 is 0, 4 + (imm8) in all other cases.

Table 20 Branch 1 Instructions [31 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
BZ/BEQ rel	2	*1	0	Branch when (Z) = 1	–	–	–	–	–	–	–	–	–	–
BNZ/BNE rel	2	*1	0	Branch when (Z) = 0	–	–	–	–	–	–	–	–	–	–
BC/BLO rel	2	*1	0	Branch when (C) = 1	–	–	–	–	–	–	–	–	–	–
BNC/BHS rel	2	*1	0	Branch when (C) = 0	–	–	–	–	–	–	–	–	–	–
BN rel	2	*1	0	Branch when (N) = 1	–	–	–	–	–	–	–	–	–	–
BP rel	2	*1	0	Branch when (N) = 0	–	–	–	–	–	–	–	–	–	–
BV rel	2	*1	0	Branch when (V) = 1	–	–	–	–	–	–	–	–	–	–
BNV rel	2	*1	0	Branch when (V) = 0	–	–	–	–	–	–	–	–	–	–
BT rel	2	*1	0	Branch when (T) = 1	–	–	–	–	–	–	–	–	–	–
BNT rel	2	*1	0	Branch when (T) = 0	–	–	–	–	–	–	–	–	–	–
BLT rel	2	*1	0	Branch when (V) xor (N) = 1	–	–	–	–	–	–	–	–	–	–
BGE rel	2	*1	0	Branch when (V) xor (N) = 0	–	–	–	–	–	–	–	–	–	–
BLE rel	2	*1	0	((V) xor (N)) or (Z) = 1	–	–	–	–	–	–	–	–	–	–
BGT rel	2	*1	0	((V) xor (N)) or (Z) = 0	–	–	–	–	–	–	–	–	–	–
BLS rel	2	*1	0	Branch when (C) or (Z) = 1	–	–	–	–	–	–	–	–	–	–
BHI rel	2	*1	0	Branch when (C) or (Z) = 0	–	–	–	–	–	–	–	–	–	–
BRA rel	2	*1	0	Branch unconditionally	–	–	–	–	–	–	–	–	–	–
JMP @A	1	2	0	word (PC) ← (A)	–	–	–	–	–	–	–	–	–	–
JMP addr16	3	2	0	word (PC) ← addr16	–	–	–	–	–	–	–	–	–	–
JMP @ear	2	3	0	word (PC) ← (ear)	–	–	–	–	–	–	–	–	–	–
JMP @eam	2+	4+ (a)	(c)	word (PC) ← (eam)	–	–	–	–	–	–	–	–	–	–
JMPP @ear *3	2	3	0	word (PC) ← (ear), (PCB) ← (ear +2)	–	–	–	–	–	–	–	–	–	–
JMPP @eam *3	2+	4+ (a)	(d)	word (PC) ← (eam), (PCB) ← (eam +2)	–	–	–	–	–	–	–	–	–	–
JMPP addr24	4	3	0	word (PC) ← ad24 0 to 15 (PCB) ← ad24 16 to 23	–	–	–	–	–	–	–	–	–	–
CALL @ear *4	2	4	(c)	word (PC) ← (ear)	–	–	–	–	–	–	–	–	–	–
CALL @eam *4	2+	5+ (a)	2× (c)	word (PC) ← (eam)	–	–	–	–	–	–	–	–	–	–
CALL addr16 *5	3	5	(c)	word (PC) ← addr16	–	–	–	–	–	–	–	–	–	–
CALLV #vct4 *5	1	5	2× (c)	Vector call linstruction	–	–	–	–	–	–	–	–	–	–
CALLP @ear *6	2	7	2× (c)	word (PC) ← (ear) 0 to 15, (PCB) ← (ear) 16 to 23	–	–	–	–	–	–	–	–	–	–
CALLP @eam *6	2+	8+ (a)	*2	word (PC) ← (eam) 0 to 15, (PCB) ← (eam) 16 to 23	–	–	–	–	–	–	–	–	–	–
CALLP addr24 *7	4	7	2× (c)	word (PC) ← addr 0 to 15, (PCB) ← addr 16 to 23	–	–	–	–	–	–	–	–	–	–

For an explanation of "(a)", "(c)" and "(d)", refer to Table 4, "Number of Execution Cycles for Each Form of Addressing," and Table 5, "Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles."

*1: 3 when branching, 2 when not branching.
*2: 3 × (c) + (b)
*3: Read (word) branch address.
*4: W: Save (word) to stack; R: Read (word) branch address.
*5: Save (word) to stack.
*6: W: Save (long word) to W stack; R: Read (long word) branch address.
*7: Save (long word) to stack.

Table 21 Branch 2 Instructions [20 Instructions]

Mnemonic	#	cycle	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
CBNE A, #imm8, rel	3	*1	0	Branch when byte (A) ≠ imm8	–	–	–	–	–	*	*	*	*	–
CWBNE A, #imm16, rel	4	*1	0	Branch when byte (A) ≠ imm16	–	–	–	–	–	*	*	*	*	–
CBNE ear, #imm8, rel	4	*1	0	Branch when byte (ear) ≠ imm8	–	–	–	–	–	*	*	*	*	–
CBNE eam, #imm8, rel	4+	*3	(b)	Branch when byte (eam) ≠ imm8	–	–	–	–	–	*	*	*	*	–
CWBNE ear, #imm16, rel	5	*1	0	Branch when word (ear) ≠ imm16	–	–	–	–	–	*	*	*	*	–
CWBNE eam, #imm16, rel	5+	*3	(c)	Branch when word (eam) ≠ imm16	–	–	–	–	–	*	*	*	*	–
DBNZ ear, rel	3	*2	0	Branch when byte (ear) = (ear) – 1, and (ear) ≠ 0	–	–	–	–	–	*	*	*	–	–
DBNZ eam, rel	3+	*4	2× (b)	Branch when byte (ear) = (eam) – 1, and (eam) ≠ 0	–	–	–	–	–	*	*	*	–	*
DWBNZ ear, rel	3	*2	0	Branch when word (ear) = (ear) – 1, and (ear) ≠ 0	–	–	–	–	–	*	*	*	–	–
DWBNZ eam, rel	3+	*4	2× (c)	Branch when word (eam) = (eam) – 1, and (eam) ≠ 0	–	–	–	–	–	*	*	*	–	*
INT #vct8	2	14	8× (c)	Software interrupt	–	–	R	S	–	–	–	–	–	–
INT addr16	3	12	6× (c)	Software interrupt	–	–	R	S	–	–	–	–	–	–
INTP addr24	4	13	6× (c)	Software interrupt	–	–	R	S	–	–	–	–	–	–
INT9	1	14	8× (c)	Software interrupt	–	–	R	S	–	–	–	–	–	–
RETI	1	9	6× (c)	Return from interrupt	–	–	*	*	*	*	*	*	*	–
RETIQ *6	2	11	*5	Return from interrupt	–	–	*	*	*	*	*	*	*	–
LINK #imm8	2	6	(c)	At constant entry, save old frame pointer to stack, set new frame pointer, and allocate local pointer area	–	–	–	–	–	–	–	–	–	–
UNLINK	1	5	(c)	At constant entry, retrieve old frame pointer from stack.	–	–	–	–	–	–	–	–	–	–
RET *7	1	4	(c)	Return from subroutine	–	–	–	–	–	–	–	–	–	–
RETP *8	1	5	(d)	Return from subroutine	–	–	–	–	–	–	–	–	–	–

For an explanation of "(b)", "(c)" and "(d)", refer to Table 5, "Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles."

*1: 4 when branching, 3 when not branching
*2: 5 when branching, 4 when not branching
*3: 5 + (a) when branching, 4 + (a) when not branching
*4: 6 + (a) when branching, 5 + (a) when not branching
*5: 3 × (b) + 2 × (c) when an interrupt request is generated, 6 × (c) when returning from the interrupt.
*6: High-speed interrupt return instruction. When an interrupt request is detected during this instruction, the instruction branches to the interrupt vector without performing stack operations when the interrupt is generated.
*7: Return from stack (word)
*8: Return from stack (long word)

Table 22 Other Control Instructions (Byte/Word/Long Word) [36 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
PUSHW A	1	3	(c)	word (SP) ← (SP) –2, ((SP)) ← (A)	–	–	–	–	–	–	–	–	–	–
PUSHW AH	1	3	(c)	word (SP) ← (SP) –2, ((SP)) ← (AH)	–	–	–	–	–	–	–	–	–	–
PUSHW PS	1	3	(c)	word (SP) ← (SP) –2, ((SP)) ← (PS)	–	–	–	–	–	–	–	–	–	–
PUSHW rlst	2	*3	*4	(SP) ← (SP) –2n, ((SP)) ← (rlst)	–	–	–	–	–	–	–	–	–	–
POPW A	1	3	(c)	word (A) ← ((SP)), (SP) ← (SP) +2	–	*	–	–	–	–	–	–	–	–
POPW AH	1	3	(c)	word (AH) ← ((SP)), (SP) ← (SP) +2	–	–	–	–	–	–	–	–	–	–
POPW PS	1	3	(c)	word (PS) ← ((SP)), (SP) ← (SP) +2	–	–	*	*	*	*	*	*	*	–
POPW rlst	2	*2	*4	(rlst) ← ((SP)) , (SP) ← (SP)	–	–	–	–	–	–	–	–	–	–
JCTX @A	1	9	6× (c)	Context switch instruction	–	–	*	*	*	*	*	*	*	–
AND CCR, #imm8	2	3	0	byte (CCR) ← (CCR) and imm8	–	–	*	*	*	*	*	*	*	–
OR CCR, #imm8	2	3	0	byte (CCR) ← (CCR) or imm8	–	–	*	*	*	*	*	*	*	–
MOV RP, #imm8	2	2	0	byte (RP) ←imm8	–	–	–	–	–	–	–	–	–	–
MOV ILM, #imm8	2	2	0	byte (ILM) ←imm8	–	–	–	–	–	–	–	–	–	–
MOVEA RWi, ear	2	3	0	word (RWi) ←ear	–	–	–	–	–	–	–	–	–	–
MOVEA RWi, eam	2+	2+ (a)	0	word (RWi) ←eam	–	–	–	–	–	–	–	–	–	–
MOVEA A, ear	2	2	0	word(A) ←ear	–	*	–	–	–	–	–	–	–	–
MOVEA A, eam	2+	1+ (a)	0	word (A) ←eam	–	*	–	–	–	–	–	–	–	–
ADDSP #imm8	2	3	0	word (SP) ← ext (imm8)	–	–	–	–	–	–	–	–	–	–
ADDSP #imm16	3	3	0	word (SP) ← imm16	–	–	–	–	–	–	–	–	–	–
MOV A, brgl	2	*1	0	byte (A) ← (brgl)	Z	*	–	–	–	*	*	–	–	–
MOV brg2, A	2	1	0	byte (brg2) ← (A)	–	–	–	–	–	*	*	–	–	–
MOV brg2, #imm8	3	2	0	byte (brg2) ← imm8	–	–	–	–	–	*	*	–	–	–
NOP	1	1	0	No operation	–	–	–	–	–	–	–	–		–
ADB	1	1	0	Prefix code for AD space access	–	–	–	–	–	–	–	–	–	–
DTB	1	1	0	Prefix code for DT space access	–	–	–	–	–	–	–	–	–	–
PCB	1	1	0	Prefix code for PC space access	–	–	–	–	–	–	–	–	–	–
SPB	1	1	0	Prefix code for SP space access	–	–	–	–	–	–	–	–	–	–
NCC	1	1	0	Prefix code for no flag change	–	–	–	–	–	–	–	–	–	–
CMR	1	1	0	Prefix code for the common register bank	–	–	–	–	–	–	–	–	–	–
MOVW SPCU, #imm16	4	2	0	word (SPCU) ← (imm16)	–	–	–	–	–	–	–	–	–	–
MOVW SPCL, #imm16	4	2	0	word (SPCL) ← (imm16)	–	–	–	–	–	–	–	–	–	–
SETSPC	2	2	0	Stack check ooperation enable	–	–	–	–	–	–	–	–	–	–
CLRSPC	2	2	0	Stack check ooperation disable	–	–	–	–	–	–	–	–	–	–
BTSCN A	2	*5	0	byte (A)← position of "1" bit in word (A)	Z	–	–	–	–	–	*	–	–	–
BTSCNS A	2	*6	0	byte (A)← position of "1" bit in word (A) ×2	Z	–	–	–	–	–	*	–	–	–
BTSCND A	2	*7	0	byte (A)← position of "1" bit in word (A) ×4	Z	–	–	–	–	–	*	–	–	–

For an explanation of "(a)" and "(c)", refer to Tables 4 and 5.

*1: PCB, ADB, SSB, USB, and SPB: 1 cycle
DTB: 2 cycles
DPR: 3 cycles

*2: 3 + 4 × (pop count)

*3: 3 + 4 × (push count)

*4: Pop count × (c), or push count × (c)

*5: 3 when AL is 0, 5 when AL is not 0.

*6: 4 when AL is 0, 6 when AL is not 0.

*7: 5 when AL is 0, 7 when AL is not 0.

Table 23 Bit Manipulation Instructions [21 Instructions]

Mnemonic		#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
MOVB	A, dir:bp	3	3	(b)	byte (A) ← (dir:bp) b	Z	*	–	–	–	*	*	–	–	–
MOVB	A, addr16:bp	4	3	(b)	byte (A) ← (addr16:bp) b	Z	*	–	–	–	*	*	–	–	–
MOVB	A, io:bp	3	3	(b)	byte (A) ← (io:bp) b	Z	*	–	–	–	*	*	–	–	–
MOVB	dir:bp, A	3	4	2× (b)	bit (dir:bp) b ← (A)	–	–	–	–	–	*	*	–	–	*
MOVB	addr16:bp, A	4	4	2× (b)	bit (addr16:bp) b ← (A)	–	–	–	–	–	*	*	–	–	*
MOVB	io:bp, A	3	4	2× (b)	bit (io:bp) b ← (A)	–	–	–	–	–	*	*	–	–	*
SETB	dir:bp	3	4	2× (b)	bit (dir:bp) b ← 1	–	–	–	–	–	–	–	–	–	*
SETB	addr16:bp	4	4	2× (b)	bit (addr16:bp) b ← 1	–	–	–	–	–	–	–	–	–	*
SETB	io:bp	3	4	2× (b)	bit (io:bp) b ← 1	–	–	–	–	–	–	–	–	–	*
CLRB	dir:bp	3	4	2× (b)	bit (dir:bp) b ← 0	–	–	–	–	–	–	–	–	–	*
CLRB	addr16:bp	4	4	2× (b)	bit (addr16:bp) b ← 0	–	–	–	–	–	–	–	–	–	*
CLRB	io:bp	3	4	2× (b)	bit (io:bp) b ← 0	–	–	–	–	–	–	–	–	–	*
BBC	dir:bp, rel	4	*1	(b)	Branch when (dir:bp) b = 0	–	–	–	–	–	–	*	–	–	–
BBC	addr16:bp, rel	5	*1	(b)	Branch when (addr16:bp) b = 0	–	–	–	–	–	–	*	–	–	–
BBC	io:bp, rel	4	*1	(b)	Branch when (io:bp) b = 0	–	–	–	–	–	–	*	–	–	–
BBS	dir:bp, rel	4	*1	(b)	Branch when (dir:bp) b = 1	–	–	–	–	–	–	*	–	–	–
BBS	addr16:bp, rel	5	*1	(b)	Branch when (addr16:bp) b = 1	–	–	–	–	–	–	*	–	–	–
BBS	io:bp, rel	4	*1	(b)	Branch when (io:bp) b = 1	–	–	–	–	–	–	*	–	–	–
SBBS	addr16:bp, rel	5	*2	2× (b)	Branch when (addr16:bp) b = 1, bit = 1	–	–	–	–	–	–	*	–	–	*
WBTS	io:bp	3	*3	*4	Wait until (io:bp) b = 1	–	–	–	–	–	–	–	–	–	–
WBTC	io:bp	3	*3	*4	Wait until (io:bp) b = 0	–	–	–	–	–	–	–	–	–	–

For an explanation of “(b)”, refer to Table 5, “Correction Values for Number of Cycles Used to Calculate Number of Actual Cycles.”

*1: 5 when branching, 4 when not branching
*2: 7 when condition is satisfied, 6 when not satisfied
*3: Undefined count
*4: Until condition is satisfied

Table 24 Accumulator Manipulation Instructions (Byte/Word) [6 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
SWAP	1	3	0	byte (A) 0 to 7 ← → (A) 8 to 15	–	–	–	–	–	–	–	–	–	–
SWAPW	1	2	0	word (AH) ← → (AL)	–	*	–	–	–	–	–	–	–	–
EXT	1	1	0	Byte code extension	X	–	–	–	–	*	*	–	–	–
EXTW	1	2	0	Word code extension	–	X	–	–	–	*	*	–	–	–
ZEXT	1	1	0	Byte zero extension	Z	–	–	–	–	R	*	–	–	–
ZEXTW	1	2	0	Word zero extension	–	Z	–	–	–	R	*	–	–	–

Table 25 String Instructions [10 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
MOVS/MOVSI	2	*2	*3	Byte transfer @AH+ ← @AL+, counter = RW0	–	–	–	–	–	–	–	–	–	–
MOVSD	2	*2	*3	Byte transfer @AH– ← @AL–, counter = RW0	–	–	–	–	–	–	–	–	–	–
SCEQ/SCEQI	2	*1	*4	Byte retrieval @AH+ – AL, counter = RW0	–	–	–	–	–	*	*	*	*	–
SCEQD	2	*1	*4	Byte retrieval @AH– – AL, counter = RW0	–	–	–	–	–	*	*	*	*	–
FILS/FILSI	2	5m +3	*5	Byte filling @AH+ ← AL, counter = RW0	–	–	–	–	–	*	*	–	–	–
MOVSW/MOVSWI	2	*2	*6	Word transfer @AH+ ← @AL+, counter = RW0	–	–	–	–	–	–	–	–	–	–
MOVSWD	2	*2	*6	Word transfer @AH– ← @AL–, counter = RW0	–	–	–	–	–	–	–	–	–	–
SCWEQ/SCWEQI	2	*1	*7	Word retrieval @AH+ – AL, counter = RW0	–	–	–	–	–	*	*	*	*	–
SCWEQD	2	*1	*7	Word retrieval @AH– – AL, counter = RW0	–	–	–	–	–	*	*	*	*	–
FILSW/FILSWI	2	5m +3	*8	Word filling @AH+ ← AL, counter = RW0	–	–	–	–	–	*	*	–	–	–

m: RW0 value (counter value)
*1: 3 when RW0 is 0, 2 + 6 × (RW0) for count out, and 6n + 4 when match occurs
*2: 4 when RW0 is 0, 2 + 6 × (RW0) in any other case
*3: (b) × (RW0)
*4: (b) × n
*5: (b) × (RW0)
*6: (c) × (RW0)
*7: (c) × n
*8: (c) × (RW0)

Table 26 Multiple Data Transfer Instructions [18 Instructions]

Mnemonic	#	cycles	B	Operation	LH	AH	I	S	T	N	Z	V	C	RMW
MOVM @A, @RLi, #imm8	3	*1	*3	Multiple data trasfer byte ((A)) ← ((RLi))	–	–	–	–	–	–	–	–	–	–
MOVM @A, eam, #imm8	3+	*2	*3	Multiple data trasfer byte ((A)) ← (eam)	–	–	–	–	–	–	–	–	–	–
MOVM addr16, @RLi, #imm8	5	*1	*3	Multiple data trasfer byte (addr16) ← ((RLi))	–	–	–	–	–	–	–	–	–	–
MOVM addr16, eam, #imm8	5+	*2	*3	Multiple data trasfer byte (addr16) ← (eam)	–	–	–	–	–	–	–	–	–	–
MOVMW @A, @RLi, #imm8	3	*1	*4	Multiple data trasfer word ((A)) ← ((RLi))	–	–	–	–	–	–	–	–	–	–
MOVMW @A, eam, #imm8	3+	*2	*4	Multiple data trasfer word ((A)) ← (eam)	–	–	–	–	–	–	–	–	–	–
MOVMW addr16, @RLi, #imm8	5	*1	*4	Multiple data trasfer word (addr16) ← ((RLi))	–	–	–	–	–	–	–	–	–	–
MOVMW addr16, eam, #imm8	5+	*2	*4	Multiple data trasfer word (addr16) ← (eam)	–	–	–	–	–	–	–	–	–	–
MOVM @RLi, @A, #imm8	3	*1	*3	Multiple data trasfer byte ((RLi)) ← ((A))	–	–	–	–	–	–	–	–	–	–
MOVM eam, @A, #imm8	3+	*2	*3	Multiple data trasfer byte (eam) ← ((A))	–	–	–	–	–	–	–	–	–	–
MOVM @RLi, addr16, #imm8	5	*1	*3	Multiple data transfer byte ((RLi)) ← (addr16)	–	–	–	–	–	–	–	–	–	–
MOVM eam, addr16, #imm8	5+	*2	*3	Multiple data transfer byte (eam) ← (addr16)	–	–	–	–	–	–	–	–	–	–
MOVMW @RLi, @A, #imm8	3	*1	*4	Multiple data trasfer word ((RLi)) ← ((A))	–	–	–	–	–	–	–	–	–	–
MOVMW eam, @A, #imm8	3+	*2	*4	Multiple data trasfer word (eam) ← ((A))	–	–	–	–	–	–	–	–	–	–
MOVMW @RLi, addr16, #imm8	5	*1	*4	Multiple data transfer word ((RLi)) ← (addr16)	–	–	–	–	–	–	–	–	–	–
MOVMW eam, addr16, #imm8	5+	*2	*4	Multiple data transfer word (eam) ← (addr16)	–	–	–	–	–	–	–	–	–	–
MOVM bnk : addr16, *5 bnk : addr16, #imm8	7	*1	*3	Multiple data transfer byte (bnk:addr16) ← (bnk:addr16)	–	–	–	–	–	–	–	–	–	–
MOVMW bnk : addr16, *5 bnk : addr16, #imm8	7	*1	*4	Multiple data transfer word (bnk:addr16) ← (bnk:addr16)	–	–	–	–	–	–	–	–	–	–

*1: 5 + imm8 × 5, 256 times when imm8 is zero.
*2: 5 + imm8 × 5 + (a), 256 times when imm8 is zero.
*3: Number of transfers × (b) × 2
*4: Number of transfers × (c) × 2
*5: The bank register specified by “bnk” is the same as for the MOVS instruction.

MB90246A Series

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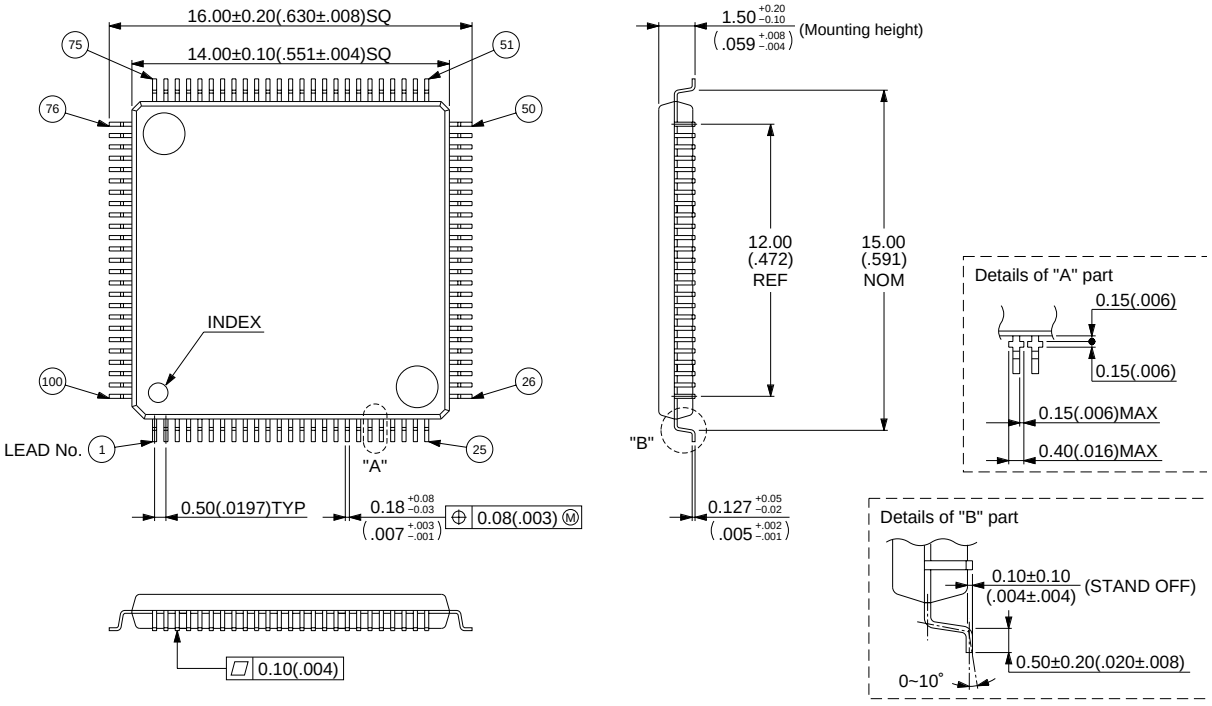

Dimensions in mm (inches)

MB90246A Series

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